

DESCRIPTION

**Surface-Coated Cutting Tool with Coated Film
Having Strength Distribution of Compressive Stress**

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Technical Field

The present invention relates to a cutting tool such as a drill, an end mill, a throw away tip for a drill, a throw away tip for an end mill, a throw away tip for milling, a throw away tip for turning, a metal saw, a gear cutting tool, a reamer, and a tap, and 10 more particularly to a surface-coated cutting tool having a coated film for improving characteristics such as wear resistance formed on its surface (an outermost layer).

Background Art

Conventionally, a hardmetal (a WC-Co alloy or an alloy obtained by adding a carbonitride of Ti (titanium), Ta (tantalum), Nb (niobium), or the like to the WC-Co 15 alloy) has been used for a cutting tool. With a growing tendency toward high-speed cutting in recent years, a hard alloy tool has more increasingly been used, the hard alloy tool being obtained by coating a surface of a base material such as a hardmetal, cermet or ceramics based on alumina or silicon nitride with a coated film composed of a carbide, a nitride, a carbonitride, a boronitride, and an oxide of IVa-, Va- and VIa-group metal in 20 the element periodic table or Al (aluminum) to a thickness of 3 to 20 μ m, with the use of CVD (Chemical Vapor Deposition) or PVD (Physical Vapor Deposition).

In particular, as coating by means of PVD can improve wear resistance without deteriorating strength of the base material, it is widely used for a cutting tool in which strength is required, such as a drill, an end mill, and a throw away tip for milling or 25 turning.

Recently, in order to further improve efficiency in a cutting process, a cutting speed has been increased. With such a tendency, further wear resistance is required in the tool. If high wear resistance is required, however, toughness is lowered. Therefore,

achievement of both high wear resistance and high toughness has been demanded.

In an attempt to meet this demand, a method of varying an internal stress such as compressive stress continuously or in a stepped manner in a coated film formed on a surface of the base material for the cutting tool has been proposed (Japanese Patent 5 Laying-Open No. 2001-315006 (Patent Document 1)). Such a proposal has produced some effect in meeting the demand for achievement of both wear resistance and toughness.

In the cutting tool according to the above-mentioned proposal, the compressive stress of the coated film uniformly increases or decreases from a side of a surface of the 10 coated film toward a side of the surface of the base material. Therefore, in order to considerably improve toughness, the compressive stress should be increased from the side of the surface of the base material toward the side of the surface of the coated film. Meanwhile, in order to considerably improve the wear resistance, the compressive stress should be increased from the side of the surface of the coated film toward the side of the 15 surface of the base material.

In other words, if maximum compressive stress is attained at the surface of the coated film, toughness is excellent whereas wear resistance is poor. This is because the compressive stress uniformly decreases, continuously or in a stepped manner, toward the surface of the base material. In contrast, if maximum compressive stress is attained 20 at the surface of the base material, wear resistance is excellent whereas toughness is poor. This is because the compressive stress uniformly decreases, continuously or in a stepped manner, toward the surface of the coated film.

In particular, in the cutting tool attaining the maximum compressive stress at the surface of the coated film, the coated film tends to self-destruct due to that large 25 compressive stress after the coated film is formed (after coating is finished) or when impact stress is applied. Then, minute film peeling (hereinafter, referred to as film chipping) tends to occur, which adversely affects appearance of the cutting tool and cutting performance in high-precision process.

As achievement of both toughness and wear resistance in the cutting tool of this kind is one of the most basic characteristics, a cutting tool attaining both of these characteristics at a higher level has been desired.

Patent Document 1: Japanese Patent Laying-Open No. 2001-315006

5 **Disclosure of the Invention**

Problems to be Solved by the Invention

The present invention was made in view of the current situation as described above, and an object of the present invention is to provide a surface-coated cutting tool achieving excellent toughness and wear resistance in a cutting tool as well as suppression of film chipping.

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Means for Solving the Problems

As a result of dedicated study for solving the above-described problems, the present inventors have conceived that, if compressive stress at a surface portion of the coated film formed as an outermost layer on the base material is lowered, the

15 compressive stress inside the coated film is increased, and a relative maximum point is formed in strength distribution of the compressive stress, development of cracking that has occurred on the surface of the coated film can be suppressed in the vicinity of the relative maximum point while high wear resistance and resistance to film chipping at the surface is maintained, and toughness may simultaneously be improved. The present invention was completed based on this conception and further study.

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Specifically, a surface-coated cutting tool according to the present invention includes a base material and a coated film formed on the base material. The coated film serves as an outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward a first intermediate point located between the surface of the coated film and a bottom surface of the coated film and the compressive stress attains a relative

maximum point at the first intermediate point. As the relative maximum point is attained at the first intermediate point, development of cracking toward the bottom surface of the coated film that has occurred on the surface of the coated film is effectively suppressed. Therefore, the first intermediate point is not located on (overlapped with) the bottom 5 surface of the coated film, but located between the surface of the coated film and the bottom surface of the coated film as described above.

The surface-coated cutting tool according to the present invention mainly includes four embodiments, namely first to fourth embodiments as described below, as 10 embodiments of the strength distribution (in particular, strength distribution from the first intermediate point toward the bottom surface of the coated film).

The strength distribution according to the first embodiment of the present invention is characterized in that a minimum compressive stress is attained at the surface of the coated film and the compressive stress maintains a constant value from the first intermediate point toward the bottom surface of the coated film.

15 Here, the compressive stress may be stress in a range from at least -15GPa to at most 0GPa. In addition, the first intermediate point may be located at a position distant from the surface of the coated film by at least 0.1% to at most 50% of the thickness of the coated film.

20 The compressive stress at the surface of the coated film may be set to a value comparable to 25 to 95% of the compressive stress at the first intermediate point of the coated film.

Alternatively, the compressive stress at the surface of the coated film may be set to a value comparable to 35 to 85% of the compressive stress at the first intermediate point of the coated film.

25 The compressive stress may attain the minimum value at the surface of the coated film, the minimum compressive stress may be maintained across a prescribed distance from the surface of the coated film toward the first intermediate point, and thereafter the compressive stress may continuously increase toward the first intermediate

point.

The strength distribution according to the second embodiment of the present invention is characterized in that the compressive stress continuously decreases from the first intermediate point toward the bottom surface of the coated film.

5 Here, the compressive stress may be stress in a range from at least -15GPa to at most 0GPa. In addition, the first intermediate point may be located at a position distant from the surface of the coated film by at least 0.1% to at most 50% of the thickness of the coated film.

10 The compressive stress may attain the minimum value at the surface of the coated film. The compressive stress at the surface of the coated film may be set to a value comparable to 25 to 95% of the compressive stress at the first intermediate point of the coated film.

15 Alternatively, the compressive stress at the surface of the coated film may be set to a value comparable to 35 to 85% of the compressive stress at the first intermediate point of the coated film.

The compressive stress at the surface of the coated film may be maintained across a prescribed distance from the surface of the coated film toward the first intermediate point, and thereafter the compressive stress may continuously increase toward the first intermediate point.

20 The strength distribution according to the third embodiment of the present invention is characterized in that the compressive stress continuously decreases from the first intermediate point toward a second intermediate point located between the first intermediate point and the bottom surface of the coated film and attains a relative minimum point at the second intermediate point.

25 Here, the compressive stress may be stress in a range from at least -15GPa to at most 0GPa. In addition, the first intermediate point may be located at a position distant from the surface of the coated film by at least 0.1% to at most 50% of the thickness of the coated film. The second intermediate point may be located at a position distant from

the surface of the coated film by at least 0.2% to at most 95% of the thickness of the coated film.

The compressive stress may attain the minimum value at the surface of the coated film. In addition, the compressive stress at the surface of the coated film may be set to a value comparable to 25 to 95% of the compressive stress at the first intermediate point of the coated film.

Alternatively, the compressive stress at the surface of the coated film may be set to a value comparable to 35 to 85% of the compressive stress at the first intermediate point of the coated film.

10 The compressive stress at the surface of the coated film may be maintained across a prescribed distance from the surface of the coated film toward the first intermediate point, and thereafter the compressive stress may continuously increase toward the first intermediate point.

15 The strength distribution according to the fourth embodiment of the present invention is characterized in that the compressive stress continuously decreases from the first intermediate point toward a second intermediate point located between the first intermediate point and the bottom surface of the coated film and attains a relative minimum point at the second intermediate point, and the strength distribution has one or more similar relative maximum point between the second intermediate point and the

20 bottom surface of the coated film.

25 In addition, the strength distribution may have one or more similar relative minimum point between the second intermediate point and the bottom surface of the coated film. The strength distribution may have one or more similar relative maximum point and one or more similar relative minimum point in an alternate and repeated manner in this order between the second intermediate point and the bottom surface of the coated film.

All relative minimum points may attain substantially identical compressive stress and all relative maximum points may attain substantially identical compressive stress.

Alternatively, all relative minimum points and all relative maximum points may have compressive stress values different from one another.

Here, the compressive stress may be stress in a range from at least -15GPa to at most 0GPa. In addition, the first intermediate point may be located at a position distant 5 from the surface of the coated film by at least 0.1% to at most 40% of the thickness of the coated film. The second intermediate point may be located at a position distant from the surface of the coated film by at least 0.2% to at most 80% of the thickness of the coated film.

10 The minimum compressive stress may be attained at the surface of the coated film, and the compressive stress at the second intermediate point of the coated film may be set to a value comparable to 10 to 80% of the compressive stress at the first intermediate point of the coated film.

15 Alternatively, the compressive stress at the second intermediate point of the coated film may be set to a value comparable to 20 to 60% of the compressive stress at the first intermediate point of the coated film.

The compressive stress at the surface of the coated film may be maintained across a prescribed distance from the surface of the coated film toward the first intermediate point, and thereafter the compressive stress may continuously increase toward the first intermediate point.

20 Effects of the Invention

Being structured as described above, the surface-coated cutting tool according to the present invention achieves both excellent toughness and excellent wear resistance as well as improved resistance to film chipping.

25 In particular, as can be seen in the strength distribution according to the first embodiment described above, the minimum compressive stress is attained at the surface of the coated film, so that wear resistance and resistance to film chipping are improved. In addition, the relative maximum point in the strength distribution of the compressive stress is formed in a portion inside the coated film close to the surface, and the

compressive stress is maintained constant from the relative maximum point toward the bottom surface of the coated film, whereby toughness is drastically improved.

In addition, as can be seen in the strength distribution according to the second embodiment described above, the compressive stress at the surface of the coated film is 5 smaller than that inside the coated film, so that wear resistance and resistance to film chipping are improved. Moreover, as the relative maximum point in the strength distribution of the compressive stress is formed in a portion inside the coated film close to the surface, development of cracking that has occurred on the surface of the coated film can be suppressed and toughness is drastically improved. In addition, the 10 compressive stress continuously decreases from the relative maximum point toward the bottom surface of the coated film, whereby further excellent wear resistance can be achieved.

Furthermore, as can be seen in the strength distribution according to the third embodiment described above, the compressive stress at the surface of the coated film is 15 smaller than that inside the coated film, so that wear resistance and resistance to film chipping are improved. Moreover, as the relative maximum point in the strength distribution of the compressive stress is formed in a portion inside the coated film close to the surface, excellent toughness is also achieved. Moreover, not only the relative maximum point but also the relative minimum point are provided, so that an effect to 20 mitigate self-destruction of the coated film or stress such as impact is achieved in the vicinity of the relative minimum point, resistance to film chipping is drastically improved, and further excellent wear resistance can be obtained.

In addition, as can be seen in the strength distribution according to the fourth embodiment described above, the compressive stress at the surface of the coated film is 25 smaller than that inside the coated film, so that wear resistance and resistance to film chipping are improved. Moreover, as the relative maximum point in the strength distribution of the compressive stress is formed in a portion inside the coated film close to the surface, excellent toughness is also achieved. Moreover, not only the relative

maximum point but also the relative minimum point are provided, so that an effect to mitigate self-destruction of the coated film or stress such as impact is achieved in the vicinity of the relative minimum point, resistance to film chipping is drastically improved, and further excellent wear resistance can be obtained. Furthermore, a plurality of such relative maximum points and relative minimum points are formed, whereby toughness and wear resistance as well as resistance to film chipping are further improved.

As described above, the present invention has successfully achieved both excellent toughness and excellent wear resistance as well as improvement in resistance to film chipping, as a result of having strength distribution of the compressive stress characterized as above.

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Brief Description of the Drawings

Fig. 1 is a schematic cross-sectional view of a surface-coated cutting tool according to the present invention.

Fig. 2 is an enlarged schematic cross-sectional view of a portion in a coated film of the surface-coated cutting tool according to the present invention.

Fig. 3 is a graph showing a first embodiment of strength distribution of compressive stress of the coated film.

Fig. 4 is a graph showing the first embodiment of strength distribution of compressive stress of the coated film when minimum compressive stress at the surface 20 of the coated film is maintained across a prescribed distance.

Fig. 5 is a schematic cross-sectional view of a surface-coated cutting tool according to the present invention having an intermediate layer formed.

Fig. 6 is a graph showing a second embodiment of strength distribution of compressive stress of the coated film.

Fig. 7 is a graph showing the second embodiment of strength distribution of compressive stress of the coated film when compressive stress at the surface of the coated film is maintained across a prescribed distance.

Fig. 8 is another enlarged schematic cross-sectional view of a portion in a coated

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film of the surface-coated cutting tool according to the present invention.

Fig. 9 is a graph showing a third embodiment of strength distribution of compressive stress of the coated film.

Fig. 10 is a graph showing the third embodiment of strength distribution of compressive stress of the coated film when compressive stress at the surface of the coated film is maintained across a prescribed distance.

Fig. 11 is yet another enlarged schematic cross-sectional view of a portion in a coated film of the surface-coated cutting tool according to the present invention.

Fig. 12 is a graph showing a fourth embodiment of strength distribution of compressive stress of the coated film.

Fig. 13 is a graph showing the fourth embodiment of strength distribution of compressive stress of the coated film when compressive stress at the surface of the coated film is maintained across a prescribed distance.

Description of the Reference Characters

1 surface-coated cutting tool; 2 base material; 3 coated film; 4 surface of coated film; 5 first intermediate point; 6 bottom surface of coated film; 7 arrow; 8 intermediate layer; 9 second intermediate point; 10 third intermediate point; and 11 fourth intermediate point.

Best Modes for Carrying Out the Invention

20 The present invention will be described hereinafter in further detail. Description of an embodiment will be given with reference to the drawings, and those having the same reference characters allotted represent the same or corresponding elements.

<Surface-Coated Cutting Tool>

As shown in Fig. 1, a surface-coated cutting tool 1 according to the present invention includes a base material 2 and a coated film 3 formed on the base material. Though coated film 3 is formed to be in direct contact with the surface of base material 2 in Fig. 1, any intermediate layer as will be described later may be formed between coated film 3 and base material 2, provided that coated film 3 serves as the outermost

layer. In the subject application, the "coated film formed on the base material" is assumed to encompass a case in which any intermediate layer is formed.

Such a surface-coated cutting tool according to the present invention can suitably be used as a cutting tool such as a drill, an end mill, a throw away tip for a drill, 5 a throw away tip for an end mill, a throw away tip for milling, a throw away tip for turning, a metal saw, a gear cutting tool, a reamer, or a tap, and among others, it is suitable for use in finish cutting or precision cutting as well as for use in turning process in particular. In these applications, the surface-coated cutting tool attains excellent 10 toughness and wear resistance. In addition, as the surface-coated cutting tool attains excellent resistance to film chipping, finished surface roughness of a material to be cut is improved. Moreover, as excellent shine on a finished surface of the material to be cut is also achieved, process simultaneous with rough finishing is allowed.

<Base Material>

Any base material that has conventionally been known as a base material for the 15 above-described kind of application may be used in the surface-coated cutting tool according to the present invention. For example, preferably, a hardmetal (such as WC-based hardmetal, a material containing Co in addition to WC, or a material to which carbonitride of Ti, Ta, Nb or the like is further added), cermet (mainly composed of TiC, 20 TiN, TiCN or the like), a high-speed steel, ceramics (titanium carbide, silicon carbide, silicon nitride, aluminum nitride, aluminum oxide, or the like), sintered cubic boron nitride, or sintered diamond is employed.

Among these various base materials, in particular, the WC-based hardmetal, cermet or sintered cubic boron nitride is preferably selected. This is because these base 25 materials are particularly excellent in balance between hardness at a high temperature and strength, and have characteristics excellent as the base material for the surface-coated cutting tool for the above-described application.

<Coated film>

The coated film according to the present invention is formed on the base material

described above and serves as the outermost layer. So long as the coated film is formed in such a manner, the coated film does not necessarily have to coat the entire surface of the base material, and a portion where the coated film is not formed or a portion not satisfying strength distribution of compressive stress which will be described later may 5 be included in the surface of the base material. It is noted that the present invention encompasses a case in which, when a coated film is once formed and thereafter a part of the surface of the coated film is removed through some post-process, a layer newly exposed is qualified as the coated film satisfying the strength distribution of the compressive stress of the present invention. In addition, the present invention also 10 encompasses a case in which, when an intermediate layer is formed between the base material and the coated film as will be described later and the coated film is removed through some post-process and the intermediate layer is exposed as the outermost layer as well, the intermediate layer in the exposed portion is qualified as the coated film satisfying the strength distribution of the compressive stress of the present invention (if 15 the intermediate layer is formed of a plurality of layers, an outermost layer (a layer serving as a surface) among the plurality of layers serves as the coated film to which the present invention is directed to).

Such a coated film is formed in order to achieve improvement in various characteristics such as wear resistance, oxidation resistance, toughness of the tool, or 20 coloring characteristic for identifying a used cutting edge portion. A composition of the coated film is not particularly limited, and a conventionally known composition can be adopted. For example, an exemplary composition includes a carbide, a nitride, an oxide, a carbonitride, an oxycarbide, an oxynitride, or a carbide-nitride-oxide of at least one element selected from the group consisting of IVa-group element (Ti, Zr, Hf or the like), 25 Va-group element (V, Nb, Ta or the like), VIa-group element (Cr, Mo, W or the like) in the element periodic table, Al (aluminum), B (boron), Si (silicon), and Ge (germanium), or a solid solution thereof.

In particular, an exemplary suitable composition includes a nitride, a carbonitride,

an oxynitride or a carbide-nitride-oxide of Ti, Al, $(\text{Ti}_{1-x}\text{Al}_x)$, $(\text{Al}_{1-x}\text{V}_x)$, $(\text{Ti}_{1-x}\text{Si}_x)$, $(\text{Al}_{1-x}\text{Cr}_x)$, $(\text{Ti}_{1-x-y}\text{Al}_x\text{Si}_y)$, or $(\text{Al}_{1-x-y}\text{Cr}_x\text{V}_y)$ (x or y represents any number not larger than 1) (a substance further containing B, Cr or the like may also be included).

More preferably, an exemplary composition includes TiCN, TiN, TiSiN, TiSiCN, 5 TiAlN , TiAlCrN , TiAlSiN , TiAlSiCrN , AlCrN , AlCrCN , AlCrVN , TiBN , TiAlBN , TiSiBN , TiBCN , TiAlBCN , TiSiBCN , AlN , AlCN , AlVN , AlVCN , and the like. In these compositions, a ratio of each atom follows the exemplary general formula described above.

It is assumed that such a coated film is formed as a single-type layer. It is noted 10 that the single-type layer herein refers to a structure in which the number of stacked layers may be set to one or more and the type of elements composing the layer is the same for each layer. Therefore, so long as the type of elements is the same, a structure formed by a plurality of layers different in a ratio of atom is also encompassed in the single-type layer herein.

15 In the coated film according to the present invention, in particular in its entirety, the type of the element and the ratio of atom are preferably the same. The single-type layer as described above, however, is assumed to encompass a super-multi-layer film structure in which one layer has a thickness less than $0.1\mu\text{m}$ and different types of elements compose respective layers (if two layers of A and B are repeatedly stacked, the 20 type of elements is different between A and B).

<Thickness of Coated film>

Though not particularly limited, the coated film according to the present invention preferably has a thickness not smaller than $0.1\mu\text{m}$ and not larger than $10\mu\text{m}$. If the thickness is less than $0.1\mu\text{m}$, in some cases, improvement in various characteristics 25 as a result of formation of the coated film cannot sufficiently be obtained. Meanwhile, if the thickness exceeds $10\mu\text{m}$, the coated film itself may readily peel off.

<Method of Forming Coated film>

Though a method of forming a coated film according to the present invention is

not particularly limited, the coated film is preferably formed with physical vapor deposition (PVD). Physical vapor deposition is adopted so that the compressive stress of the coated film can readily be varied so as to form strength distribution.

5 Namely, according to the study made by the present inventors, it has been found that the compressive stress of the coated film is affected by a temperature, a reactive gas pressure, a substrate bias voltage or the like when the coated film is formed with physical vapor deposition, and that it is most affected, among others, by the substrate bias voltage in particular at the time of formation of the coated film.

10 The reason is considered as follows. Specifically, for example, when a large substrate bias voltage is applied to the base material, an element composing the coated film is supplied in an ionized state to the base material at high energy. Then, impact when the element collides with the base material becomes greater, and consequently the compressive stress of the formed coated film becomes greater. In contrast, it is presumed that, if the substrate bias voltage is low, impact due to collision between the 15 base material and the element in the ionized state is also small and consequently the compressive stress is also small.

20 Therefore, the strength distribution of the compressive stress of the coated film in a direction of thickness of the coated film can be obtained by adopting physical vapor deposition and by adjusting the substrate bias voltage when the coated film is formed on the base material. As will be described later, adjustment by means of mechanical impact or thermal shock, or annealing phenomenon using heat is also possible.

25 Though physical vapor deposition is preferably adopted as the method of forming the coated film according to the present invention, it is not intended to exclude chemical vapor deposition known as another method of forming a coated film.

 An exemplary physical vapor deposition method includes a conventionally known method such as sputtering or ion plating in which a substrate bias voltage can be adjusted. Particularly, among various methods, ion plating or magnetron sputtering is preferably adopted.

Ion plating refers to the following method. Specifically, a metal is used as the cathode and a vacuum chamber is used as the anode. Then, the metal is evaporated and ionized, and concurrently a negative voltage (substrate bias voltage) is applied to the base material, so that ions are drawn and metal ions are deposited on the surface of the base material. In this method, if nitrogen is supplied into the vacuum and caused to react with the metal, a nitride of that metal is formed. For example, if titanium is employed as the metal and caused to react with nitrogen, titanium nitrogen (TiN) is formed.

There are various types of ion plating, however, cathode arc ion plating attaining high ion proportion of a raw element is particularly preferably adopted.

With the use of cathode arc ion plating, metal ion bombardment process on the surface of the base material can be performed before the coated film is formed. Accordingly, remarkable improvement in adhesion of the coated film can also effectively be achieved. Therefore, from the viewpoint of adhesion, cathode arc ion plating is a preferable process.

Meanwhile, magnetron sputtering refers to the following method. Specifically, after a vacuum chamber attains high vacuum, an Ar gas is introduced and a high voltage is applied to a target so as to cause glow discharge. Then, the target is irradiated with accelerated Ar ionized by the glow discharge, and the target is sputtered. The target atom that has flown out and been ionized is accelerated by the substrate bias voltage between the target and the substrate and deposited on the base material, whereby a film is formed. An exemplary magnetron sputtering method includes balanced magnetron sputtering, unbalanced magnetron sputtering and the like.

A method of controlling the substrate bias voltage using physical vapor deposition has been shown as a method of forming strength distribution of the compressive stress of the coated film, however, the present invention is not limited solely thereto. For example, a method of applying compressive stress by means of mechanical impact such as blast after formation of the coated film, a method of

mitigating the compressive stress by using a heat source such as a heater, laser or the like, or a combined method of the former is possible.

<Compressive Stress of Coated film>

The coated film according to the present invention has compressive stress.

5 Preferably, the compressive stress is stress in a range from at least -15GPa to at most 0GPa. More preferably, the lower limit of the compressive stress is set to -10GPa and further preferably to -8GPa, while the upper limit thereof is more preferably set to -0.5GPa and further preferably to -1GPa.

10 If the compressive stress of the coated film is lower than -15GPa, the coated film may peel off particularly at a ridgeline portion of the cutting edge, depending on a shape of the cutting tool (such as a tool having a cutting edge with an extremely small included angle or a tool having a complicated shape). Meanwhile, if the compressive stress of the coated film is higher than 0GPa, the stress of the coated film enters a tensile state. Then, a cracking is caused in the coated film, which results in chipping of the tool 15 itself.

20 The compressive stress used herein represents one type of internal stress (intrinsic strain) present in the coated film, and is expressed by a "−" (minus) numeric value (unit: GPa). Therefore, the expression "large compressive stress (internal stress)" indicates that the absolute value of the numeric value above is large, whereas the expression "small compressive stress (internal stress)" indicates that the absolute value of the numeric value above is small.

25 The compressive stress in the present invention is measured with a $\sin^2\psi$ method. The $\sin^2\psi$ method using an X-ray is widely used as a method of measuring residual stress in a polycrystalline material. This measurement method is described in detail on pages 54-66 of "X-ray Stress Measurement" (The Society of Materials Science, Japan, 1981, published by Yokendo Co., Ltd.). In the present invention, initially, a penetration depth of the X-ray is fixed by combining an inclination method and a side inclination method, and various angles of diffraction 2θ with respect to ψ direction are measured in

5 a plane including a direction of stress to be measured and a sample surface normal provided at a measurement position, so as to prepare a $2\theta-\sin^2\psi$ diagram. Average compressive stress to that depth (a distance from the surface of the coated film) can be found based on a gradient of the diagram. Similarly, the average compressive stress to a different depth is sequentially measured and a mathematical method is used to find the strength distribution of the compressive stress in a direction of thickness of the coated film.

10 More specifically, in a method of measuring the stress with the use of X-ray in which an X-ray from an X-ray source enters a sample at a prescribed angle, the X-ray diffracted by the sample is detected by an X-ray detector, and the internal stress is measured based on the detection value, the compressive stress inside the sample can be found in the following manner. An X-ray from an X-ray source enters a surface of the sample at an arbitrary portion of the sample at an arbitrarily set angle. When the sample is rotated around a ω axis passing through an X-ray irradiation point of the sample and forming at a right angle to the incident X-ray at the surface of the sample and around a χ axis coinciding with the incident X-ray when the ω axis is rotated in parallel to a sample carrier, the sample is rotated such that an angle between the surface of the sample and the incident X-ray is maintained constant, and an angle ψ between the normal on a diffraction surface and the normal on a sample surface is varied, to measure a diffraction beam.

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25 Here, synchrotron radiation (SR) is preferably employed as the X-ray source for finding the strength distribution in the direction of thickness of the coated film, from the viewpoint of a quality of the X-ray source (such as high luminance, high parallelism, wavelength variability, or the like).

In order to find the compressive stress from the $2\theta-\sin^2\psi$ diagram as described above, a Young's modulus and a Poisson's ratio of the coated film are necessary. Here, the Young's modulus can be measured by means of a dynamic hardness meter or the like, and as the Poisson's ratio, a value set around 0.2 is used. This is because the Poisson's

ratio is not significantly varied from material to material. In the present invention, the strength distribution of the compressive stress is important, rather than particularly accurate compressive stress value. Therefore, in finding the compressive stress from the $2\theta-\sin^2\psi$ diagram, finding a lattice constant and an interplanar spacing instead of using the Young's modulus could replace the strength distribution of the compressive stress.

<Strength Distribution>

The compressive stress of the coated film according to the present invention is varied to have the strength distribution in the direction of thickness of the coated film. Here, the direction of thickness of the coated film refers to a direction from the surface of the coated film toward the bottom surface of the coated film (as the coated film serves as the outermost layer on the base material, the bottom surface refers to a surface closest to the base material, of the outermost layer) and a direction perpendicular to the surface of the coated film. Detailed description will be given with reference to Fig. 2 showing an enlarged cross-sectional view of a portion of coated film 3 of Fig. 1. Here, the direction in the thickness of the coated film is shown with an arrow 7 from a surface 4 of the coated film toward a bottom surface 6 of the coated film. Though arrow 7 is directed from surface 4 of the coated film to bottom surface 6 of the coated film for the sake of convenience, the direction is not necessarily limited to such an up-to-down direction, so long as the direction is perpendicular to the surface of the coated film. That is, the direction of thickness of the coated film may be directed from bottom surface 6 of the coated film to surface 4 of the coated film.

The strength distribution represents variation in a magnitude of the compressive stress in a manner forming distribution in the direction of thickness of the coated film. In other words, the strength distribution of the compressive stress in the direction of thickness of the coated film refers to variation in the magnitude of the compressive stress not in the direction in parallel to the surface of the coated film but in the direction perpendicular to the surface of the coated film.

The strength distribution is characterized in that the compressive stress attained

at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point. In the following, first to fourth
5 embodiments of the strength distribution will be described in detail.

<Strength Distribution --First Embodiment>

The first embodiment of the strength distribution is characterized in that the minimum compressive stress (in other words, the compressive stress attaining the smallest absolute value) is attained at the surface of the coated film, that the compressive
10 stress continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and attains a relative maximum point at the first intermediate point, and that the compressive stress maintains a constant value from the first intermediate point toward the bottom surface of the coated film.

15 This characteristic will be described in detail with reference to Fig. 2 and Fig. 3 showing the first embodiment of the strength distribution of the present invention. Fig. 3 is a graph showing the strength distribution, in which the abscissa represents a distance from the surface of the coated film in the direction of thickness of the coated film and the ordinate represents the compressive stress.

20 Initially, as shown in Fig. 2, a first intermediate point 5 is located between surface 4 of the coated film and bottom surface 6 of the coated film. With regard to a distance in a perpendicular direction from surface 4 of the coated film, first intermediate point 5 does not necessarily have to be located at a position at a distance from the surface comparable to 1/2 of the thickness of the coated film (distance in the
25 perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). Normally, first intermediate point 5 is located closer to surface 4 of the coated film than to bottom surface 6 of the coated film.

Preferably, first intermediate point 5 is located at a position at a distance from

surface 4 of the coated film comparable to at least 0.1% to at most 50% of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.3% and further preferably to 0.5% of the thickness, while the upper 5 limit thereof is suitably set to 40% and further preferably to 35% of the same. If the distance less than 0.1% of the thickness is set and when the tool is used in finish cutting or precision cutting, reduction in the compressive stress is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in the finished 10 surface roughness may not be exhibited. In addition, if the distance larger than 50% of the thickness is set, an effect from increase in the compressive stress inside the coated film is lowered and improvement in toughness may not be exhibited.

Preferably, the compressive stress at the surface of the coated film is set to 25 to 95% of the compressive stress at the first intermediate point of the coated film. More 15 preferably, the upper limit of the compressive stress at the surface is set to 90% and further preferably to 85% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 30% and further preferably to 35% of the same.

If the compressive stress at the surface of the coated film less than 25% of the compressive stress at the first intermediate point is set, sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the surface of the coated film exceeds 20 95% of the compressive stress at the first intermediate point, an effect of reduction in the compressive stress at the surface of the coated film is lowered and effect of suppression of film chipping may not be exhibited.

The relative maximum point is observed at first intermediate point 5 in terms of a position (in Fig. 3, a point distant from the surface of the coated film by approximately 25 0.1 μ m), and it is shown that the compressive stress attaining the minimum value at the surface of the coated film (compressive stress having a value of approximately -1.8GPa in Fig. 3) continuously increases toward bottom surface 6 of the coated film and a degree of increase changes at the relative maximum point. Here, change in the degree of

increase means that the value of the compressive stress starts to become constant toward the bottom surface of the coated film on reaching the relative maximum point, as shown in Fig. 3. Therefore, the meaning of relative maximum point herein is identical to, or broader than, the meaning of a relative maximum point which is a term used in connection with a function in mathematics.

In Fig. 3, the compressive stress attains the minimum only at the surface of the coated film (that is, a point distant from the surface of the coated film by 0 μm), however, the embodiment of the present invention is not limited to such a case that the minimum compressive stress is attained only at the point distant from the surface of the coated film by 0 μm . Namely, as shown in Fig. 4, the present invention encompasses also a case in which the minimum compressive stress is maintained from the surface of the coated film toward the bottom surface of the coated film across a prescribed distance range (preferably not larger than 0.5 μm). In other words, the present invention includes an embodiment in which the compressive stress attains the minimum at the surface of the coated film, the minimum compressive stress is maintained across a prescribed distance (preferably not larger than 0.5 μm) from the surface of the coated film toward the first intermediate point, and thereafter the compressive stress continuously increases toward the first intermediate point.

As described above, when the minimum compressive stress at the surface of the coated film is maintained across a prescribed distance range from the surface of the coated film toward the bottom surface of the coated film, particularly excellent effect in suppression of film chipping and wear resistance is attained, which is preferable.

The case in which the compressive stress continuously increases from the surface of the coated film toward the first intermediate point encompasses not only a case in which the compressive stress increases in a manner convex upward as shown in Fig. 3 but also a case in which the compressive stress increases in a manner convex downward or linearly increases. In addition, provided that the compressive stress increases from the surface of the coated film toward the first intermediate point as a whole, the case of

continuous increase herein encompasses a case in which the compressive stress decreases in a part, or a case in which the degree (slope) of increase changes at some midpoint, or the change is made in a stepped manner (increase in the stepped manner).

5 The case in which the value of the compressive stress is maintained constant from the first intermediate point toward the bottom surface of the coated film encompasses not only a case in which the compressive stress is set to an exactly constant value but also a case in which the compressive stress is set to a substantially constant value.

10 As described above, according to the first embodiment of the strength distribution of the present invention, the compressive stress attains the minimum value at the surface of the coated film, and the compressive stress continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and attains the relative maximum point at the first intermediate point. The minimum compressive stress 15 is attained at the surface of the coated film, so that wear resistance at the surface of the coated film is improved as much as possible and resistance to film chipping is also improved. In addition, large compressive stress is attained in the vicinity of the relative maximum point and the compressive stress is maintained constant from the first intermediate point toward the bottom surface of the coated film, whereby excellent 20 toughness is provided.

In this manner, the surface-coated cutting tool according to the present invention attains an extremely excellent effect in successfully achieving toughness, wear resistance and resistance to film chipping.

25 Such an excellent effect cannot be exhibited in the conventional surface-coated cutting tool (Patent Document 1) characterized in that there is no relative maximum point and that the compressive stress uniformly increases or decreases from the surface of the coated film toward the bottom surface of the coated film continuously or in a stepped manner.

<Strength Distribution --Second Embodiment>

5 The second embodiment of the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the bottom surface of the coated film.

10 This characteristic will be described in detail with reference to Fig. 2 and Fig. 6 showing the second embodiment of the strength distribution of the present invention. Fig. 6 is a graph showing the strength distribution, in which the abscissa represents a distance from the surface of the coated film in the direction of thickness of the coated film and the ordinate represents the compressive stress.

15 Initially, as shown in Fig. 2, first intermediate point 5 is located between surface 4 of the coated film and bottom surface 6 of the coated film. With regard to a distance in a perpendicular direction from surface 4 of the coated film, first intermediate point 5 does not necessarily have to be located at a position at a distance from the surface comparable to 1/2 of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film).
20 Normally, first intermediate point 5 is located closer to surface 4 of the coated film than to bottom surface 6 of the coated film.

25 Preferably, first intermediate point 5 is located at a position at a distance from the surface of the coated film comparable to at least 0.1% to at most 50% of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.3% and further preferably to 0.5% of the thickness, while the upper limit thereof is suitably set to 40% and further preferably to 35% of the same. If the distance less than 0.1% of the thickness is set and when the tool is used in finish

5 cutting or precision cutting, reduction in the compressive stress is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in the finished surface roughness may not be exhibited. In addition, if the distance larger than 50% of the thickness is set, an effect from increase in the compressive stress inside the coated film is lowered and improvement in toughness may not be exhibited.

10 In such strength distribution, the compressive stress may attain the minimum value at surface 4 of the coated film (in other words, the compressive stress attains the smallest absolute value). Accordingly, particularly excellent wear resistance and resistance to film chipping can be obtained. Meanwhile, the compressive stress may attain the minimum value also at bottom surface 6 of the coated film (in other words, the compressive stress attains the smallest absolute value). Particularly excellent wear resistance can thus be obtained.

15 Preferably, the compressive stress at the surface of the coated film is set to 25 to 95% of the compressive stress at the first intermediate point of the coated film. More preferably, the upper limit of the compressive stress at the surface is set to 90% and further preferably to 85% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 30% and further preferably to 35% of the same.

20 If the compressive stress at the surface of the coated film less than 25% of the compressive stress at the first intermediate point is set, sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the surface of the coated film exceeds 95% of the compressive stress at the first intermediate point, an effect of reduction in the compressive stress at the surface of the coated film is lowered and effect of suppression of film chipping may not be exhibited.

25 The relative maximum point is observed at the first intermediate point in terms of a position (in Fig. 6, a point distant from the surface of the coated film by approximately $0.1\mu\text{m}$), and it is indicated that the compressive stress at the surface of the coated film (compressive stress having a value of approximately -1.8GPa in Fig. 6) continuously increases toward bottom surface 6 of the coated film and the degree of increase changes

at the relative maximum point. Here, change in the degree of increase means that the value of the compressive stress starts to continuously decrease toward the bottom surface of the coated film on reaching the relative maximum point, as shown in Fig. 6.

In Fig. 6, the relative maximum point is present only at the first intermediate point, however, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the relative maximum point is present with a certain thickness in the direction of thickness of the coated film. Here, the relative maximum point being present with a certain thickness refers to a case in which the compressive stress at the relative maximum point is maintained substantially constant from the first intermediate point across that thickness (preferably, not larger than 1/2 of the thickness of the coated film). As described above, the relative maximum point is present with a certain thickness from the first intermediate point, so that toughness can further be improved.

Therefore, the meaning of relative maximum point herein is identical to, or broader than, the meaning of a relative maximum point which is a term used in connection with a function in mathematics.

In Fig. 6, the compressive stress continuously increases from the surface of the coated film (that is, a point distant from the surface of the coated film by 0 μm), however, the embodiment of the present invention is not limited thereto. Namely, for example, as shown in Fig. 7, the present invention encompasses also a case in which the compressive stress at the surface of the coated film is maintained toward the bottom surface of the coated film across a prescribed distance range (preferably not larger than 0.5 μm). In other words, the present invention includes an embodiment in which the compressive stress at the surface of the coated film is smaller than in the inside (in other words, the absolute value of that compressive stress at the surface is smaller than the absolute value of the compressive stress in the inside), and the compressive stress is maintained across a prescribed distance (preferably not larger than 0.5 μm) from the surface of the coated film toward the first intermediate point and thereafter continuously increases toward the

first intermediate point.

As described above, when the compressive stress at the surface of the coated film is maintained across a prescribed distance range from the surface of the coated film toward the bottom surface of the coated film, particularly excellent effect of suppression of film chipping and wear resistance is attained, which is preferable.

The case in which the compressive stress continuously increases from the surface of the coated film toward the first intermediate point encompasses not only a case in which the compressive stress increases in a manner convex upward as shown in Fig. 6 but also a case in which the compressive stress increases in a manner convex downward or linearly increases. In addition, provided that the compressive stress increases from the surface of the coated film toward the first intermediate point as a whole, the case of continuous increase herein encompasses a case in which the compressive stress decreases in a part, or a case in which the degree (slope) of increase changes at some midpoint, or the change is made in a stepped manner (increase in the stepped manner).

The case that the compressive stress continuously decreases from the first intermediate point toward the bottom surface of the coated film encompasses not only a case in which the compressive stress decreases in a manner convex upward as shown in Fig. 6 but also a case in which the compressive stress decreases in a manner convex downward or linearly decreases. In addition, provided that the compressive stress decreases from the first intermediate point toward the bottom surface of the coated film as a whole, the case of continuous decrease herein encompasses a case in which the compressive stress increases in a part, or a case in which the degree (slope) of decrease changes at some midpoint, or the change is made in a stepped manner (decrease in the stepped manner).

As described above, according to the second embodiment of the strength distribution of the present invention, the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface

of the coated film and the compressive stress attains the relative maximum point at the first intermediate point. The compressive stress at the surface of the coated film is smaller than that in the inside, so that wear resistance at the surface of the coated film is improved as much as possible and resistance to film chipping is also improved. In 5 addition, large compressive stress is attained in the vicinity of the relative maximum point, whereby excellent toughness is provided.

Moreover, according to the second embodiment of the strength distribution of the present invention, the compressive stress continuously decreases from the first intermediate point toward the bottom surface of the coated film, so that extremely 10 excellent wear resistance is provided. In this manner, the surface-coated cutting tool according to the present invention attains an extremely excellent effect in successfully achieving toughness, wear resistance and resistance to film chipping.

Such an excellent effect cannot be exhibited in the conventional surface-coated cutting tool (Patent Document 1) characterized in that there is no relative maximum 15 point and that the compressive stress uniformly increases or decreases from the surface of the coated film toward the bottom surface of the coated film continuously or in a stepped manner.

<Strength Distribution --Third Embodiment>

The third embodiment of the strength distribution is characterized in that the 20 compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the 25 second intermediate point located between the first intermediate point and the bottom surface of the coated film and attains the relative minimum point at the second intermediate point.

This characteristic will be described in detail with reference to Fig. 8 and Fig. 9

showing the third embodiment of the strength distribution of the present invention. Fig. 9 is a graph showing the strength distribution, in which the abscissa represents a distance from the surface of the coated film in the direction of thickness of the coated film and the ordinate represents the compressive stress.

5 Initially, as shown in Fig. 8, first intermediate point 5 is located between surface 4 of the coated film and bottom surface 6 of the coated film. With regard to a distance in a perpendicular direction from surface 4 of the coated film, first intermediate point 5 does not necessarily have to be located at a position at a distance from the surface comparable to 1/2 of the thickness of the coated film (distance in the perpendicular 10 direction from surface 4 of the coated film to bottom surface 6 of the coated film). Normally, first intermediate point 5 is located closer to surface 4 of the coated film than to bottom surface 6 of the coated film.

15 Preferably, first intermediate point 5 is located at a position at a distance from surface 4 of the coated film comparable to at least 0.1% to at most 50% of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film and bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.3% and further preferably to 0.5% of the thickness, while the upper limit thereof is suitably set to 40% and further preferably to 35% of the same. If the distance less than 0.1% of the thickness is set and when the tool is used in finish cutting 20 or precision cutting, reduction in the compressive stress is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in the finished surface roughness may not be exhibited. In addition, if the distance larger than 50% of the thickness is set, an effect from increase in the compressive stress inside the coated film is lowered and improvement in toughness may not be exhibited.

25 In such strength distribution, the compressive stress may attain the minimum at surface 4 of the coated film (in other words, the compressive stress attains the smallest absolute value). Accordingly, particularly excellent wear resistance can be obtained.

Preferably, the compressive stress at the surface of the coated film is set to 25 to

95% of the compressive stress at the first intermediate point of the coated film. More preferably, the upper limit of the compressive stress at the surface is set to 90% and further preferably to 85% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 30% and further preferably to 35% of the same.

5 If the compressive stress at the surface of the coated film less than 25% of the compressive stress at the first intermediate point is set, sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the surface of the coated film exceeds 95% of the compressive stress at the first intermediate point, an effect of reduction in the compressive stress at the surface of the coated film is lowered and effect of suppression of film chipping may not be exhibited.

10 The relative maximum point is observed at the first intermediate point in terms of a position (in Fig. 9, a point distant from the surface of the coated film by approximately $0.1\mu\text{m}$), and it is indicated that the compressive stress at the surface of the coated film (compressive stress having a value of approximately -1.8GPa in Fig. 9) continuously increases toward bottom surface 6 of the coated film and the degree of increase changes at the relative maximum point. Here, change in the degree of increase means that the compressive stress starts to continuously decrease toward the second intermediate point 15 on reaching the relative maximum point, as shown in Fig. 9.

15 In Fig. 9, the relative maximum point is present only at the first intermediate point, however, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the relative maximum point is present with a certain thickness in the direction of thickness of the coated film. Here, the relative maximum point being present with a certain thickness refers to a case in which the compressive stress at the relative maximum point is maintained substantially constant from the first 20 intermediate point across that thickness (preferably, not larger than 1/2 of the thickness of the coated film). As described above, the relative maximum point is present with a certain thickness from the first intermediate point, so that toughness can further be improved.

Therefore, the meaning of relative maximum point herein is identical to, or broader than, the meaning of a relative maximum point which is a term used in connection with a function in mathematics.

Meanwhile, as shown in Fig. 8, a second intermediate point 9 is located between first intermediate point 5 and bottom surface 6 of the coated film, however, second intermediate point 9 does not necessarily have to be located at a position at a distance from first intermediate point 5 comparable to 1/2 of the distance in the perpendicular direction from first intermediate point 5 to bottom surface 6 of the coated film.

Normally, such second intermediate point 9 is located at a position closer to first intermediate point 5 than to bottom surface 6 of the coated film.

Preferably, second intermediate point 9 is located at a position at a distance from the surface of the coated film comparable to at least 0.2% to at most 95% of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.5% and further preferably to 1.0% of the thickness, while the upper limit thereof is suitably set to 90% and further preferably to 80% of the same. If the distance less than 0.2% of the thickness is set, application of the compressive stress is insufficient and improvement in toughness may not be exhibited. In addition, if the distance larger than 95% of the thickness is set, reduction in the compressive stress is insufficient, and an effect of suppression of film chipping and effect of improvement in wear resistance may not be exhibited.

Preferably, the compressive stress at the second intermediate point is set to 20 to 90% of the compressive stress at the first intermediate point (relative maximum point). More preferably, the upper limit of the compressive stress at the second intermediate point is set to 85% and further preferably to 80% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 30% and further preferably to 40% of the same.

If the compressive stress at the second intermediate point less than 20% of the

compressive stress at the first intermediate point is set, reduction in the compressive stress is excessive and sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the second intermediate point exceeds 90% of the compressive stress at the first intermediate point, impact absorption (relaxation of stress) is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in wear resistance may not be obtained.

The relative minimum point is observed at the second intermediate point in terms of a position (in Fig. 9, a point distant from the surface of the coated film by approximately $0.4\mu\text{m}$), and it is indicated that the compressive stress at first intermediate point 5 (compressive stress having a value of approximately -5GPa in Fig. 9) continuously decreases toward bottom surface 6 of the coated film and the degree of decrease changes at the relative minimum point. Here, change in the degree of decrease means that the compressive stress starts to continuously increase toward bottom surface 6 of the coated film on reaching the relative minimum point, as shown in Fig. 9.

In Fig. 9, the relative minimum point is present only at the second intermediate point, however, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the relative minimum point is present with a certain thickness in the direction of thickness of the coated film. Here, the relative minimum point being present with a certain thickness refers to a case in which the compressive stress at the relative minimum point is maintained substantially constant from the second intermediate point across that thickness (preferably, not larger than 1/2 of the thickness of the coated film). As described above, the relative minimum point is present with a certain thickness from the second intermediate point, so that wear resistance can further be improved.

Therefore, the meaning of relative minimum point herein is identical to, or broader than, the meaning of a relative minimum point which is a term used in connection with a function in mathematics.

Though Fig. 9 shows an embodiment in which the compressive stress

continuously increases from the second intermediate point toward the bottom surface of the coated film, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the compressive stress is maintained constant (substantially constant) from the second intermediate point to the bottom surface of the 5 coated film. When the compressive stress continuously increases from the second intermediate point toward the bottom surface of the coated film, excellent toughness is attained. On the other hand, when the compressive stress maintains a constant value from the second intermediate point to the bottom surface of the coated film, an effect of further improvement in wear resistance is exhibited.

10 In Fig. 9, the compressive stress continuously increases from the surface of the coated film (that is, a point distant from the surface of the coated film by 0 μ m), however, the embodiment of the present invention is not limited thereto. Namely, for example, as shown in Fig. 10, the present invention also encompasses a case in which the compressive stress at the surface of the coated film is maintained toward the bottom 15 surface of the coated film across a prescribed distance range (preferably not larger than 0.5 μ m). In other words, the present invention includes an embodiment in which the compressive stress at the surface of the coated film is smaller than in the inside (in other words, the absolute value of the compressive stress at the surface is smaller than that in the inside), and the compressive stress is maintained across a prescribed distance from the surface of the coated film toward the first intermediate point (preferably not larger 20 than 0.5 μ m), and thereafter continuously increases toward the first intermediate point.

25 As described above, when the compressive stress at the surface of the coated film is maintained across a prescribed distance range from the surface of the coated film toward the bottom surface of the coated film, particularly excellent effect in suppression of film chipping and wear resistance is attained, which is preferable.

The case that the compressive stress continuously decreases in the subject application encompasses not only a case in which the compressive stress decreases in a manner convex upward as shown in Fig. 9 but also a case in which the compressive

stress decreases in a manner convex downward or linearly decreases. In addition, provided that the compressive stress decreases as a whole, the case of continuous decrease in the subject application encompasses a case in which the compressive stress increases in a part, or a case in which the degree (slope) of decrease changes at some 5 midpoint, or the change is made in a stepped manner (decrease in the stepped manner).

The case that the compressive stress continuously increases in the subject application encompasses not only a case in which the compressive stress increases in a manner convex upward or convex downward as shown in Fig. 9 but also a case in which the compressive stress linearly increases. In addition, provided that the compressive 10 stress increases as a whole, the case of continuous increase in the subject application encompasses a case in which the compressive stress decreases in a part, or a case in which the degree (slope) of increase changes at some midpoint, or the change is made in a stepped manner (increase in the stepped manner).

As described above, according to the third embodiment of the strength 15 distribution of the present invention, the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point. The compressive stress at the surface of the coated film is 20 smaller than that in the inside, so that wear resistance is improved and excellent resistance to film chipping is also achieved. In addition, pronounced effect of excellent toughness in the vicinity of the relative maximum point is exhibited.

Moreover, according to the third embodiment of the strength distribution of the present invention, the compressive stress continuously decreases from the first 25 intermediate point toward the second intermediate point and attains the relative minimum point at the second intermediate point, so that further excellent wear resistance is provided. In this manner, the surface-coated cutting tool according to the present invention attains an extremely excellent effect in successfully achieving toughness, wear

resistance and resistance to film chipping.

Such an excellent effect cannot be exhibited in the conventional surface-coated cutting tool (Patent Document 1) characterized in that there is no relative maximum point nor relative minimum point and that the compressive stress uniformly increases or decreases from the surface of the coated film toward the bottom surface of the coated film continuously or in a stepped manner.

5 **<Strength Distribution --Fourth Embodiment>**

The fourth embodiment of the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the 10 surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the second intermediate point located between the first intermediate point and the bottom 15 surface of the coated film and attains the relative minimum point at the second intermediate point, and the strength distribution has one or more similar relative maximum point between the second intermediate point and the bottom surface of the coated film.

Here, the similar relative maximum point refers to a point where the compressive 20 stress exhibits a behavior on the strength distribution, the same as that at the relative maximum point represented as the first intermediate point, and, for example, refers to a point at which the degree of increase in the compressive stress is changed after the compressive stress continuously increases from the second intermediate point toward the bottom surface of the coated film. As described above, one or more relative 25 maximum point is provided between the second intermediate point and the bottom surface of the coated film, so that further excellent toughness can be obtained, development of cracking toward inside of the coated film that has occurred on the surface of the coated film can more effectively be suppressed, and resistance to film

chipping is further improved.

Meanwhile, the strength distribution may have one or more similar relative minimum point between the second intermediate point and the bottom surface of the coated film.

5 Here, the similar relative minimum point refers to a point where the compressive stress exhibits a behavior on the strength distribution, the same as that at the relative minimum point represented as the second intermediate point, and, for example, refers to a point at which the degree of decrease in the compressive stress is changed after the compressive stress continuously decreases from the relative maximum point located
10 between the second intermediate point and the bottom surface of the coated film toward the bottom surface of the coated film. As described above, one or more relative minimum point is provided between the second intermediate point and the bottom surface of the coated film, so that development of cracking toward inside of the coated film that has occurred on the surface of the coated film can more effectively be
15 suppressed, resistance to film chipping is further improved, and further excellent wear resistance is exhibited.

20 The strength distribution may have one or more similar relative maximum point and one or more similar relative minimum point between the second intermediate point and the bottom surface of the coated film in an alternate and repeated manner in this order. Here, the number of times of repetition and an interval of repetition are not particularly limited. If the relative maximum points (including the relative maximum point at the first intermediate point) and the relative minimum points (including the relative minimum point at the second intermediate point) are present at substantially equal intervals, the number of times of repetition can be determined in connection with
25 the thickness of the coated film, such that a distance between the relative maximum points and the distance between the relative minimum points are in a range from 0.1% to 70% of the thickness of the coated film, and such that the upper limit of the distance is preferably set to 60% and more preferably to 50% of the thickness, while the lower limit

thereof is preferably set to 0.15% and more preferably to 0.2% of the thickness.

If the distance less than 0.1% of the thickness is set, the interval of repetition is too short to attain a stable stress state of the coated film, which results in likeliness of film chipping. Meanwhile, if the distance larger than 70% of the thickness is set, an effect of formation of a plurality of relative minimum points or relative maximum points may be lowered.

As described above, the plurality of relative maximum points and relative minimum points are present in an alternate and repeated manner in this order, so that the number of points where development energy of cracking that has occurred on the surface of the coated film can be absorbed is increased. Therefore, development of cracking toward inside of the coated film can more effectively be suppressed, resistance to film chipping is further improved, and further excellent wear resistance and toughness is exhibited.

Various characteristics of the strength distribution described above will be discussed in detail with reference to Fig. 11 and Fig. 12 showing the fourth embodiment of the strength distribution of the present invention. Fig. 12 is a graph showing the strength distribution, in which the abscissa represents a distance from the surface of the coated film in the direction of thickness of the coated film and the ordinate represents the compressive stress.

Initially, as shown in Fig. 11, first intermediate point 5 is located between surface 4 of the coated film and bottom surface 6 of the coated film. With regard to a distance in a perpendicular direction from surface 4 of the coated film, first intermediate point 5 does not necessarily have to be located at a position at a distance from the surface comparable to 1/2 of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). Normally, first intermediate point 5 is located closer to surface 4 of the coated film than to bottom surface 6 of the coated film.

Preferably, first intermediate point 5 is located at a position at a distance from

surface 4 of the coated film comparable to at least 0.1% to at most 40% of the thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.3% and further preferably to 0.5% of the thickness, while the upper 5 limit thereof is suitably set to 35% and further preferably to 30% of the same. If the distance less than 0.1% of the thickness is set and the tool is used in finish cutting or precision cutting, reduction in the compressive stress is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in the finished surface roughness may not be exhibited. In addition, if the distance larger than 40% of the thickness is set, 10 an effect from increase in the compressive stress inside the coated film is lowered and improvement in toughness may not be exhibited.

In such strength distribution, the compressive stress may attain the minimum at surface 4 of the coated film (in other words, the compressive stress attains the smallest absolute value). Accordingly, particularly excellent toughness can be obtained.

15 Preferably, the compressive stress at the surface of the coated film is set to 25 to 95% of the compressive stress at the first intermediate point of the coated film. More preferably, the upper limit of the compressive stress at the surface is set to 90% and further preferably to 85% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 30% and further preferably to 35% of the same. If the 20 compressive stress at the surface of the coated film less than 25% of the compressive stress at the first intermediate point is set, sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the surface of the coated film exceeds 95% of the compressive stress at the first intermediate point, an effect of reduction in the compressive stress at the surface of the coated film is lowered, impact absorption 25 (relaxation of stress) is incomplete, and effect of suppression of film chipping may not be exhibited.

A plurality of relative maximum points are present from surface 4 of the coated film toward bottom surface 6 of the coated film. As to the position, the first relative

maximum point from the side of surface 4 of the coated film appears at the first intermediate point described above, and a relative maximum point is observed at any one or more point between second intermediate point 9 and bottom surface 6 of the coated film (for example, a third intermediate point 10 in Fig. 11). Here, such a relative 5 maximum point refers to a point where the compressive stress exhibits such a behavior on the strength distribution that the degree of increase in the compressive stress is changed after the compressive stress continuously increases toward bottom surface 6 of the coated film. Here, change in the degree of increase means that the compressive stress that has increased toward bottom surface 6 of the coated film starts to 10 continuously decrease on reaching the relative maximum point.

Though Fig. 11 shows solely third intermediate point 10 as representing second or later relative maximum points, such representation is for the sake of convenience. The second or later relative maximum point is not limited as such.

In Fig. 12, the relative maximum point is present as a point not having a width in 15 the direction of thickness of the coated film, however, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the relative maximum point is present with a thickness (width) in the direction of thickness of the coated film. Here, the case that the relative maximum point is present with a certain thickness refers to a case in which the compressive stress at the relative maximum point 20 maintains a substantially constant value across that thickness (preferably, not larger than 1/2 of the thickness of the coated film). As described above, the relative maximum point is present with a certain thickness, so that toughness can further be improved.

Therefore, the meaning of relative maximum point herein is identical to, or 25 broader than, the meaning of a relative maximum point which is a term used in connection with a function in mathematics.

Meanwhile, as shown in Fig. 11, second intermediate point 9 is located between first intermediate point 5 and bottom surface 6 of the coated film, however, second intermediate point 9 does not necessarily have to be located at a position comparable to

1/2 of the distance in the perpendicular direction from first intermediate point 5 to bottom surface 6 of the coated film.

Preferably, second intermediate point 9 is located at a position at a distance from the surface of the coated film comparable to at least 0.2% to at most 80% of the

5 thickness of the coated film (distance in the perpendicular direction from surface 4 of the coated film to bottom surface 6 of the coated film). More preferably, the lower limit of that distance is set to 0.5% and further preferably to 1% of the thickness, while the upper limit thereof is suitably set to 75% and further preferably to 70% of the same. If the distance less than 0.2% of the thickness is set, application of the compressive stress

10 is insufficient and an effect of improvement in toughness may not be exhibited. In addition, if the distance larger than 80% of the thickness is set, reduction in the compressive stress is insufficient, and an effect of suppression of film chipping and an effect of improvement in wear resistance may not be exhibited.

Preferably, the compressive stress at the second intermediate point is set to 10 to 15 80% of the compressive stress at the first intermediate point (relative maximum point).

More preferably, the upper limit of the compressive stress at the second intermediate point is set to 70% and further preferably to 60% of the compressive stress at the first intermediate point, while the lower limit thereof is set to 15% and further preferably to 20% of the same. If two or more relative minimum points are present, each relative

20 minimum point preferably has the compressive stress in the above-described range.

If the compressive stress at the second intermediate point less than 10% of the compressive stress at the first intermediate point is set, reduction in the compressive stress is excessive and sufficient toughness may not be obtained. Meanwhile, if the compressive stress at the second intermediate point exceeds 80% of the compressive stress at the first intermediate point, impact absorption (relaxation of stress) is incomplete, effect of suppression of film chipping is lowered, and effect of improvement in wear resistance may not be exhibited.

One or more relative minimum point is present from surface 4 of the coated film

toward bottom surface 6 of the coated film. As to the position, the first relative minimum point from the side of surface 4 of the coated film appears at second intermediate point 9 described above. If second or later relative minimum point is present, the relative minimum point is observed at any one or more point between 5 second intermediate point 9 and bottom surface 6 of the coated film (for example, a fourth intermediate point 11 in Fig. 11). Such a relative minimum point refers to a point where the compressive stress exhibits such a behavior on the strength distribution that the degree of decrease in the compressive stress is changed after the compressive stress continuously decreases toward bottom surface 6 of the coated film. Here, change in the 10 degree of decrease means that the compressive stress that has decreased toward bottom surface 6 of the coated film starts to continuously increase on reaching the relative minimum point.

Though Fig. 11 shows solely fourth intermediate point 11 as representing second or later relative minimum point, such representation is for the sake of convenience. The 15 second or later relative minimum point is not limited as such.

In Fig. 12, the relative minimum point is present as a point not having a width in the direction of thickness of the coated film, however, the embodiment of the present invention is not limited thereto, and encompasses also a case in which the relative minimum point is present with a thickness (width) in the direction of thickness of the 20 coated film. Here, the case that the relative minimum point is present with a certain thickness refers to a case in which the compressive stress at the relative minimum point maintains a substantially constant value across that thickness (preferably, not larger than 1/2 of the thickness of the coated film). As described above, the relative minimum point is present with a certain thickness, so that wear resistance can further be improved.

25 Therefore, the meaning of relative minimum point herein is identical to, or broader than, the meaning of a relative minimum point which is a term used in connection with a function in mathematics.

The relative maximum points and the relative minimum points are preferably

present between surface 4 of the coated film and bottom surface 6 of the coated film in an alternate and repeated manner in this order, as shown in Fig. 12. In addition, preferably, the relative maximum points and the relative minimum points are present at equal or unequal intervals, and the compressive stress is present as a substantially 5 identical value at each relative maximum point or at each relative minimum point.

In Fig. 12, the compressive stress continuously increases from the surface of the coated film (that is, a point distant from the surface of the coated film by $0\mu\text{m}$), however, the embodiment of the present invention is not limited thereto. Namely, for example, as 10 shown in Fig. 13, the present invention encompasses a case in which the compressive stress at the surface of the coated film is maintained toward the bottom surface of the coated film across a prescribed distance range (preferably not larger than $0.5\mu\text{m}$). In other words, the present invention includes an embodiment in which the compressive stress at the surface of the coated film is smaller than in the inside (in other words, the absolute value of the compressive stress at the surface is smaller than the absolute value 15 thereof in the inside), and the compressive stress is maintained across a prescribed distance from the surface of the coated film toward the first intermediate point (preferably not larger than $0.5\mu\text{m}$) and thereafter continuously increases toward the first intermediate point.

As described above, when the compressive stress at the surface of the coated 20 film is maintained across a prescribed distance range from the surface of the coated film toward the bottom surface of the coated film, particularly excellent effect in suppression of film chipping and wear resistance is attained, which is preferable.

The case that the compressive stress continuously decreases in the subject 25 application encompasses not only a case in which the compressive stress decreases in a manner convex upward as shown in Fig. 12 but also a case in which the compressive stress decreases in a manner convex downward or linearly decreases. In addition, provided that the compressive stress decreases as a whole, the case of continuous decrease in the subject application encompasses a case in which the compressive stress

increases in a part, or a case in which the degree (slope) of decrease changes at some midpoint, or the change is made in a stepped manner (decrease in the stepped manner).

The case that the compressive stress continuously increases in the subject application encompasses not only a case in which the compressive stress increases in a manner convex upward or convex downward as shown in Fig. 12 but also a case in which the compressive stress linearly increases. In addition, provided that the compressive stress increases as a whole, the case of continuous increase in the subject application encompasses a case in which the compressive stress decreases in a part, or a case in which the degree (slope) of increase changes at some midpoint, or the change is made in a stepped manner (increase in the stepped manner).

It is noted that, in the strength distribution described above, a point closest to bottom surface 6 of the coated film may be either the relative minimum point or the relative maximum point. Therefore, the compressive stress on bottom surface 6 of the coated film may be in increase or in decrease, or alternatively, the relative minimum point or the relative maximum point may coincide with bottom surface 6.

As described above, according to the fourth embodiment of the strength distribution of the present invention, the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point. The compressive stress at the surface of the coated film is smaller than that in the inside, so that wear resistance is improved and excellent resistance to film chipping is also achieved. In addition, pronounced effect of excellent toughness in the vicinity of the relative maximum point is exhibited.

Moreover, according to the fourth embodiment of the strength distribution of the present invention, the compressive stress continuously decreases from the first intermediate point toward the second intermediate point and attains the relative minimum point at the second intermediate point, so that further excellent wear resistance

is provided. Furthermore, according to the fourth embodiment of the strength distribution of the present invention, a plurality of relative maximum points and relative minimum points are present between the second intermediate point and the bottom surface of the coated film in an alternate and repeated manner in this order. Therefore, 5 development of cracking toward inside of the coated film that has occurred on the surface of the coated film can more effectively be suppressed, resistance to film chipping is further improved, and further excellent wear resistance and toughness is exhibited.

In this manner, the surface-coated cutting tool according to the present invention attains an extremely excellent effect in successfully achieving toughness, wear resistance 10 and resistance to film chipping.

Such an excellent effect cannot be exhibited in the conventional surface-coated cutting tool (Patent Document 1) characterized in that there is no relative maximum point nor relative minimum point and that the compressive stress uniformly increases or decreases from the surface of the coated film toward the bottom surface of the coated 15 film continuously or in a stepped manner.

<Others>

In the surface-coated cutting tool according to the present invention, an arbitrary intermediate layer 8 may be formed between base material 2 and coated film 3 as shown in Fig. 5. Such intermediate layer 8 normally has a property to improve wear resistance 20 or adhesion between the base material and the coated film, and may be implemented by a single layer or a plurality of layers. Here, bottom surface 6 of the coated film serves as a contact surface between coated film 3 and intermediate layer 8.

Such an intermediate layer may be composed, for example, of TiN, TiCN, TiSiN, TiAlN, AlCrN, AlVN, TiAlCrN, TiAlSiN, TiAlSiCrN, AlCrVN, or the like. In these 25 compositions, a ratio of each atom follows an example of a general formula exemplified as the composition for the coated film.

<Example>

In the following, the present invention will be described in detail with reference

to examples, however, the present invention is not limited thereto. A compound composition of the coated film in the examples was confirmed by an XPS (X-ray photoelectron spectroscopic analyzer). In addition, the compressive stress and the thickness (or a distance from the surface of the coated film) were measured with the $\sin^2\psi$ method described above.

In measurement using the $\sin^2\psi$ method, energy of used X-ray was set to 10keV, and diffraction peak was set to a (200) plane of $Ti_{0.5}Al_{0.5}N$ (Examples 1 to 6, Examples 11 to 16, Examples 21 to 26, and Examples 31 to 36), $Al_{0.7}Cr_{0.3}N$ (Examples 7 to 10), $Al_{0.7}Cr_{0.25}V_{0.05}N$ (Examples 17 to 20), $Ti_{0.8}Si_{0.2}N$ (Examples 27 to 30), and $Ti_{0.7}Si_{0.2}Cr_{0.1}N$ (Examples 37 to 40). Then, a measured diffraction peak position was determined by fitting of a Gauss function, and the slope of the $2\theta-\sin^2\psi$ diagram was found. In addition, a value found by using a dynamic hardness meter (Nanoindenter manufactured by MTS Systems Corporation) was adopted as the Young's modulus, and a value of TiN (0.19) was adopted as the Poisson's ratio. A stress value was thus set.

The coated film hereinafter was formed by using cathode arc ion plating, however, the film may be formed also by using balanced or unbalanced sputtering. In addition, though a coated film of a specific composition was formed hereinafter, a similar effect can be obtained also from a coated film of a different composition.

<Examples 1 to 6>

<Fabrication of Surface-Coated Cutting Tool>

Initially, as the base material for the surface-coated cutting tool, a throw away tip for cutting having a material and a tool shape (different depending on a method of evaluating each characteristic which will be described later) shown in Table 1 below was prepared, and the throw away tip (base material) was attached to a cathode arc ion plating apparatus.

Table 1

	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Base Material (JIS)	K10 hardmetal	K10 hardmetal	P10 cermet
Shape of Tool	CNMG120408	CNMG120408	CCMT120404
Material to be Cut	SCM415	SCM435 (4 grooves)	S45C (4 grooves)
Cutting Speed (m/min)	400	150	200
Feed (mm/rev)	0.15	0.25	0.2
Cutting (mm)	2.0	1.5	0.5
Oil for Cutting	Used	Not used	Used

In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.5}Al_{0.5}N$ is formed to a thickness of 3μm as a coated film formed on the base material to be in direct contact therewith. Nitrogen gas serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 2 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples

1 to 6 having strength distribution of the compressive stress shown in Table 3 below was fabricated.

Table 2

No.	Substrate Bias Voltage / Elapsed Time	
Example 1	Start to 35 minutes -150V	35 minutes to 60 minutes -150V to -50V
Example 2	Start to 35 minutes -150V	35 minutes to 60 minutes -150V to -70V
Example 3	Start to 45 minutes -150V	45 minutes to 60 minutes -150V to -120V
Example 4	Start to 45 minutes -150V	45 minutes to 60 minutes -150V to -60V
Example 5	Start to 55 minutes -150V	55 minutes to 60 minutes -150V to -100V
Example 6	Start to 58 minutes -150V	58 minutes to 60 minutes -150V to -100V

5 The time in Table 2 above shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the voltage in each field shows a substrate bias voltage set during the elapsed time described above. For example, if a single numeric value such as "-150V" is shown, it indicates that the substrate bias voltage was constant during the elapsed time. Here, the
10 compressive stress of the coated film also maintains a constant value. Meanwhile, if a range such as "-150V to -50V" is shown, it indicates that the substrate bias voltage was gradually decreased from -150V to -50V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually decreases, and the relative maximum point of the compressive stress is formed at a point where the voltage starts to
15 decrease.

 The substrate bias voltage was varied or set to a constant value relative to the elapsed time, so that the relative maximum point or a section where the compressive stress maintains a constant value can be formed in the strength distribution of the compressive stress in the coated film.

Table 3

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point
Example 1	-2.0GPa	40.0% (1.2μm)	-5.0GPa
Example 2	-2.8GPa	40.0% (1.2μm)	-5.0GPa
Example 3	-4.3GPa	23.3% (0.7μm)	-5.1GPa
Example 4	-2.1GPa	23.3% (0.7μm)	-5.1GPa
Example 5	-4.0GPa	6.7% (0.2μm)	-5.2GPa
Example 6	-4.1GPa	1.7% (0.05μm)	-5.2GPa

It is noted that a numeric value in a field of the compressive stress at the surface in Table 3 above shows the minimum compressive stress exhibited at the surface of the coated film. In addition, a numeric value in a field of the first intermediate point shows a distance in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with "μm"). Moreover, a numeric value in a field of the relative maximum point shows the compressive stress at that relative maximum point. This compressive stress is maintained constant (the same value) toward the bottom surface of the coated film.

The surface-coated cutting tool according to the present invention in Examples 1 to 6 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the minimum compressive stress is attained at the surface of the coated film, and the compressive stress continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and attains the relative maximum point at the first intermediate point, and that the compressive stress maintains a constant value from the first

intermediate point to the bottom surface of the coated film. That is, this strength distribution shows the strength distribution according to the first embodiment described above.

5 For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was maintained at -150V for 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 1).

10 In the surface-coated cutting tool according to Comparative Example 1, there was no strength distribution of the compressive stress of the coated film and the compressive stress was constant from the bottom surface of the coated film to the surface of the coated film.

<Examples 7 to 10>

<Fabrication of Surface-Coated Cutting Tool>

15 Initially, a base material the same as that used in Examples 1 to 6 was employed as the base material for the surface-coated cutting tool, and this base material was attached to a cathode arc ion plating apparatus.

20 In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

25 Then, a target made of alloy serving as a metal evaporation source was set such that $Al_{0.7}Cr_{0.3}N$ is formed to a thickness of 3μm as a coated film formed on the base material to be in direct contact therewith. Nitrogen serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the

reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 4 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 5 7 to 10 having strength distribution of the compressive stress shown in Table 5 below was fabricated.

Table 4

No.	Substrate Bias Voltage / Elapsed Time	
Example 7	Start to 55 minutes -200V	55 minutes to 60 minutes -200V to -75V
Example 8	Start to 55 minutes -150V	55 minutes to 60 minutes -150V to -75V
Example 9	Start to 55 minutes -120V	55 minutes to 60 minutes -120V to -75V
Example 10	Start to 55 minutes -90V	55 minutes to 60 minutes -90V to -75V

10 The time in Table 4 above, as in Table 2, shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the voltage in each field, as in Table 2, shows a substrate bias voltage set during the elapsed time described above.

Table 5

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point
Example 7	-3.0GPa	6.7% (0.2μm)	-8.0GPa
Example 8	-3.1GPa	6.7% (0.2μm)	-5.0GPa
Example 9	-3.1GPa	6.7% (0.2μm)	-4.4GPa
Example 10	-3.2GPa	6.7% (0.2μm)	-3.8GPa

15 It is noted that a numeric value in a field of the compressive stress at the surface in Table 5 above, as in Table 3, shows the minimum compressive stress exhibited at the surface of the coated film. In addition, a numeric value in a field of the first intermediate

point, as in Table 3, also shows a distance in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with " μm "). Moreover, a numeric value in a field of the relative maximum point, as in Table 3, also shows the compressive stress at that point. This compressive stress maintains a constant value (the same value) to the bottom surface of the coated film.

The surface-coated cutting tool according to the present invention in Examples 7 to 10 includes the base material and the coated film formed on the base material. The 10 coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the minimum compressive stress is attained at the surface of the coated film, the 15 compressive stress continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and attains the relative maximum point at the first intermediate point, and that the compressive stress maintains a constant value from the first intermediate point to the bottom surface of the coated film. That is, this strength distribution shows the strength distribution according to the first embodiment described 20 above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was uniformly decreased from -200V to -20V taking 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 2).

25 In the surface-coated cutting tool according to Comparative Example 2, the strength distribution of the compressive stress of the coated film had no relative maximum point and the compressive stress uniformly decreased from the bottom surface of the coated film toward the surface of the coated film.

<Evaluation of Wear-Resistance of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 1 to 10 and Comparative Examples 1 and 2 fabricated as above was subjected to a continuous cutting test and an interrupted cutting test under the condition shown in Table 1 above.

5 Then, the time at which a flank wear width at the cutting edge exceeds 0.15mm was measured as the cutting time.

Tables 6 and 7 show a cutting time measured as described above as the result of evaluation of wear resistance of the surface-coated cutting tool. As the cutting time is longer, wear resistance is superior. In addition, in the continuous cutting test, shine on a 10 finished surface of a material to be cut was also observed. Tables 6 and 7 also show a result of observation. Here, "shiny" indicates that the finished surface of the material to be cut had a shine, while "dim" indicates that the finished surface of the material to be cut had no shine but was dim.

As can clearly be seen from Tables 6 and 7, in both of the continuous cutting test 15 and the interrupted cutting test, as compared with the surface-coated cutting tool in Comparative Examples 1 and 2, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 1 to 10 attained further improved wear resistance (see the continuous cutting test) and toughness (see the interrupted cutting test), excellent resistance to film chipping as a result of shine on the finished surface, and 20 further improved life.

<Evaluation of Shine on Finished Surface of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 1 to 10 and Comparative Examples 1 and 2 fabricated as above was subjected to a test for evaluating shine on the finished surface under the condition shown below.

25 As to the condition for cutting, specifically, as shown in Table 1 above, S45C was used as a material to be cut. A wet turning test was performed for 10 minutes under such a condition that a cutting speed was set to 200m/min, a feed rate was set to 0.2mm/rev, and cutting was set to 0.5mm.

5

Tables 6 and 7 show the result of evaluation of shine on the finished surface of each surface-coated cutting tool. As can clearly be seen from Tables 6 and 7, as compared with the surface-coated cutting tool in Comparative Examples 1 and 2, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 1 to 10 attained further improved shine on the finished surface and excellent resistance to film chipping.

Table 6

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 1	89 minutes (shiny)	19 minutes	Excellent shine
Example 2	82 minutes (shiny)	21 minutes	Excellent shine
Example 3	71 minutes (shiny)	29 minutes	Good shine
Example 4	85 minutes (shiny)	24 minutes	Excellent shine
Example 5	77 minutes (shiny)	31 minutes	Good shine
Example 6	65 minutes (shiny)	36 minutes	Good shine
Comparative Example 1	13 minutes (dim)	3 minutes	Dim

Table 7

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 7	85 minutes (shiny)	31 minutes	Good shine
Example 8	84 minutes (shiny)	27 minutes	Good shine
Example 9	84 minutes (shiny)	25 minutes	Good shine
Example 10	83 minutes (shiny)	24 minutes	Good shine
Comparative Example 2	41 minutes (shiny)	3 seconds	Chipping observed in 1 minute

10

<Examples 11 to 16>

<Fabrication of Surface-Coated Cutting Tool>

Initially, as the base material for the surface-coated cutting tool, a throw away

tip for cutting having a material and a tool shape (different depending on a method of evaluating each characteristic which will be described later) shown in Table 1 above was prepared, and the throw away tip (base material) was attached to a cathode arc ion plating apparatus.

5 In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

10 Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

15 Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.5}Al_{0.5}N$ is formed to a thickness of $3\mu m$ as a coated film formed on the base material to be in direct contact therewith. Nitrogen gas serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 8 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, 20 whereby the surface-coated cutting tool according to the present invention of Examples 11 to 16 having strength distribution of the compressive stress shown in Table 9 below was fabricated.

Table 8

No.	Substrate Bias Voltage / Elapsed Time	
Example 11	Start to 35 minutes -70V to -150V	35 minutes to 60 minutes -150V to -50V
Example 12	Start to 35 minutes -70V to -150V	35 minutes to 60 minutes -150V to -70V
Example 13	Start to 45 minutes -70V to -150V	45 minutes to 60 minutes -150V to -120V
Example 14	Start to 45 minutes -60V to -150V	45 minutes to 60 minutes -150V to -60V
Example 15	Start to 55 minutes -50V to -150V	55 minutes to 60 minutes -150V to -100V
Example 16	Start to 58 minutes -50V to -150V	58 minutes to 60 minutes -150V to -100V

The time in Table 8 above shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the voltage in each field shows a substrate bias voltage set during the elapsed time described above. For example, if a range such as "-70V to -150V" is shown, it indicates that the substrate bias voltage was gradually increased from -70V to -150V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually increases. Meanwhile, if a range such as "-150V to -50V" is shown, it indicates that the substrate bias voltage was gradually decreased from -150V to -50V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually decreases, and the relative maximum point of the compressive stress is formed at a point where the voltage started to decrease.

The substrate bias voltage was varied relative to the elapsed time, so that the relative maximum point or continuous increase or decrease in the strength distribution of the compressive stress in the coated film can be formed.

Table 9

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Compressive Stress at Bottom Surface
Example 11	-2.1GPa	40.0% (1.2μm)	-5.0GPa	-3.0GPa
Example 12	-2.9GPa	40.0% (1.2μm)	-5.1GPa	-3.0GPa
Example 13	-4.4GPa	23.3% (0.7μm)	-5.1GPa	-3.1GPa
Example 14	-2.3GPa	23.3% (0.7μm)	-5.0GPa	-2.4GPa
Example 15	-4.1GPa	6.7% (0.2μm)	-4.9GPa	-2.0GPa
Example 16	-4.0GPa	1.7% (0.05μm)	-5.0GPa	-2.1GPa

It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 9 above show 5 compressive stresses exhibited at the surface of the coated film and at the bottom surface of the coated film respectively. In addition, a numeric value in a field of the first intermediate point shows a distance in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with "μm"). Moreover, a numeric value in a field of the relative maximum point shows 10 the compressive stress at that relative maximum point.

The surface-coated cutting tool according to the present invention in Examples 11 to 16 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive 15 stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress 20 attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the

bottom surface of the coated film. That is, this strength distribution shows the strength distribution according to the second embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was maintained at 5 $-150V$ for 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 3).

In the surface-coated cutting tool according to Comparative Example 3, there was no strength distribution of the compressive stress of the coated film and the compressive stress was constant from the bottom surface of the coated film to the 10 surface of the coated film.

<Examples 17 to 20>

<Fabrication of Surface-Coated Cutting Tool>

Initially, a base material the same as that used in Examples 11 to 16 was employed as the base material for the surface-coated cutting tool, and this base material 15 was attached to a cathode arc ion plating apparatus.

In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to $1.0 \times 10^{-4}\text{Pa}$.

20 Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa . The voltage of a substrate bias power supply of the base material was gradually raised to $-1500V$, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

25 Then, a target made of alloy serving as a metal evaporation source was set such that $\text{Al}_{0.7}\text{Cr}_{0.25}\text{V}_{0.05}\text{N}$ is formed to a thickness of $3\mu\text{m}$ as a coated film formed on the base material to be in direct contact therewith. Nitrogen serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C and the reactive gas pressure was set to 4.0Pa , and the substrate bias voltage was varied as

shown in Table 10 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 17 to 20 having strength distribution of the compressive stress shown in Table 11 below was fabricated.

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Table 10

No.	Substrate Bias Voltage / Elapsed Time	
Example 17	Start to 55 minutes -100V to -200V	55 minutes to 60 minutes -200V to -70V
Example 18	Start to 55 minutes -100V to -170V	55 minutes to 60 minutes -170V to -70V
Example 19	Start to 55 minutes -50V to -120V	55 minutes to 60 minutes -120V to -70V
Example 20	Start to 55 minutes -50V to -100V	55 minutes to 60 minutes -100V to -70V

10 The time in Table 10 above, as in Table 8, shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the voltage in each field, as in Table 8, shows a substrate bias voltage set during the elapsed time described above.

Table 11

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Compressive Stress at Bottom Surface
Example 17	-3.1GPa	6.7% (0.2μm)	-7.9GPa	-4.0GPa
Example 18	-3.0GPa	6.7% (0.2μm)	-5.9GPa	-3.8GPa
Example 19	-3.2GPa	6.7% (0.2μm)	-4.5GPa	-2.0GPa
Example 20	-3.1GPa	6.7% (0.2μm)	-4.0GPa	-1.9GPa

15 It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 11 above, as in Table 9, show compressive stresses exhibited at the surface of the coated film and at the

bottom surface of the coated film respectively. In addition, a numeric value in a field of the first intermediate point, as in Table 9, also shows a distance in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with " μm "). Moreover, a numeric value in a field of the relative maximum point, as in Table 9, also shows the compressive stress at that point.

The surface-coated cutting tool according to the present invention in Examples 17 to 20 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the bottom surface of the coated film. That is, this strength distribution shows the strength distribution according to the second embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was uniformly decreased from -200V to -20V taking 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 4).

In the surface-coated cutting tool according to Comparative Example 4, the strength distribution of the compressive stress of the coated film had no relative maximum point and the compressive stress uniformly decreased from the bottom surface of the coated film toward the surface of the coated film.

<Evaluation of Wear-Resistance of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 11 to 20 and Comparative Examples 3 and 4 fabricated as above was subjected to a continuous cutting test and an interrupted cutting test under the condition shown in Table 1 above. Then, the time at which a flank wear width at the cutting edge exceeds 0.15mm was measured as the cutting time.

Tables 12 and 13 show the cutting time measured as described above as the result of evaluation of wear resistance of the surface-coated cutting tool. As the cutting time is longer, wear resistance is superior. In addition, in the continuous cutting test, shine on a finished surface of a material to be cut was also observed. Tables 12 and 13 also show the result of observation: Here, "shiny" indicates that the finished surface of the material to be cut had a shine, while "dim" indicates that the finished surface of the material to be cut had no shine but was dim.

As can clearly be seen from Tables 12 and 13, in both of the continuous cutting test and the interrupted cutting test, as compared with the surface-coated cutting tool in Comparative Examples 3 and 4, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 11 to 20 attained further improved wear resistance (see the continuous cutting test) and toughness (see the interrupted cutting test), excellent resistance to film chipping as a result of shine on the finished surface, and further improved life.

20 <Evaluation of Shine on Finished Surface of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 11 to 20 and Comparative Examples 3 and 4 fabricated as above was subjected to a test for evaluating shine on the finished surface under the condition shown below.

As to the condition for cutting, specifically, as shown in Table 1 above, S45C was used as a material to be cut. A wet turning test was performed for 10 minutes under such a condition that a cutting speed was set to 200m/min, a feed rate was set to 0.2mm/rev, and cutting was set to 0.5mm.

Tables 12 and 13 show the result of evaluation of shine on the finished surface of

5

each surface-coated cutting tool. As can clearly be seen from Tables 12 and 13, as compared with the surface-coated cutting tool in Comparative Examples 3 and 4, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 11 to 20 attained further improved shine on the finished surface and excellent resistance to film chipping.

Table 12

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 11	105 minutes (shiny)	17 minutes	Excellent shine
Example 12	100 minutes (shiny)	19 minutes	Excellent shine
Example 13	82 minutes (shiny)	27 minutes	Excellent shine
Example 14	102 minutes (shiny)	22 minutes	Excellent shine
Example 15	85 minutes (shiny)	27 minutes	Excellent shine
Example 16	75 minutes (shiny)	33 minutes	Excellent shine
Comparative Example 3	12 minutes (dim)	3 minutes	Dim

Table 13

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 17	95 minutes (shiny)	27 minutes	Good shine
Example 18	101 minutes (shiny)	25 minutes	Good shine
Example 19	94 minutes (shiny)	23 minutes	Excellent shine
Example 20	92 minutes (shiny)	22 minutes	Excellent shine
Comparative Example 4	40 minutes (dim)	3 seconds	Chipping observed in 1 minute

10

<Examples 21 to 26>

<Fabrication of Surface-Coated Cutting Tool>

Initially, as the base material for the surface-coated cutting tool, a throw away tip for cutting having a material and a tool shape (different depending on a method of

evaluating each characteristic which will be described later) shown in Table 1 above was prepared, and the throw away tip (base material) was attached to a cathode arc ion plating apparatus.

5 In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

10 Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

15 Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.5}Al_{0.5}N$ is formed to a thickness of 3μm as a coated film formed on the base material to be in direct contact therewith. Nitrogen gas serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 14 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 20 21 to 26 having strength distribution of the compressive stress shown in Table 15 below was fabricated.

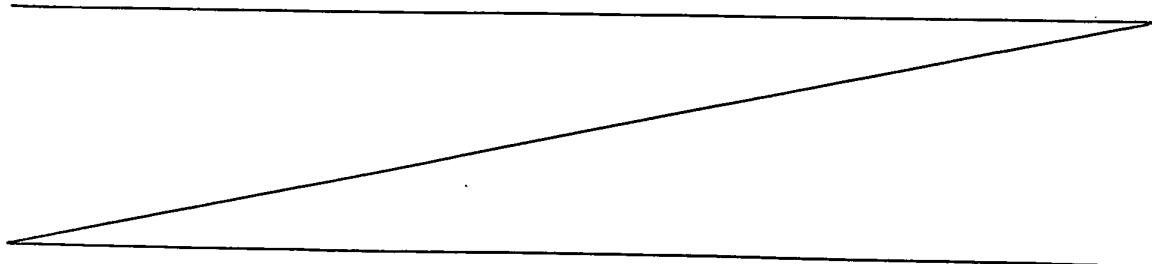


Table 14

No.	Substrate Bias Voltage / Elapsed Time		
Example 21	Start to 20 minutes -170V to -70V	20 minutes to 35 minutes -70V to -150V	35 minutes to 60 minutes -150V to -50V
Example 22	Start to 20 minutes -170V to -70V	20 minutes to 35 minutes -70V to -150V	35 minutes to 60 minutes -150V to -70V
Example 23	Start to 20 minutes -170V to -70V	20 minutes to 45 minutes -70V to -150V	45 minutes to 60 minutes -150V to -120V
Example 24	Start to 30 minutes -170V to -70V	30 minutes to 45 minutes -70V to -150V	45 minutes to 60 minutes -150V to -60V
Example 25	Start to 30 minutes -170V to -70V	30 minutes to 55 minutes -70V to -150V	55 minutes to 60 minutes -150V to -100V
Example 26	Start to 30 minutes -170V to -70V	30 minutes to 58 minutes -70V to -150V	58 minutes to 60 minutes -150V to -100V

The time in Table 14 above shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the

5 voltage in each field shows a substrate bias voltage set during the elapsed time described above. For example, if a range such as "-170V to -70V" is shown, it indicates that the substrate bias voltage was gradually decreased from -170V to -70V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually decreases. Meanwhile, if a range such as "-70V to -150V" is shown, it indicates that

10 the substrate bias voltage was gradually increased from -70V to -150V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually increases. The relative minimum point and the relative maximum point of the compressive stress are formed at a point where the decrease in the voltage turns to increase and at a point where the increase in the voltage turns to decrease, respectively.

15 The substrate bias voltage was varied relative to the elapsed time, so that the relative minimum point and the relative maximum point or continuous decrease or increase in the strength distribution of the compressive stress in the coated film can be formed.

Table 15

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Second Intermediate Point	Relative Minimum Point	Compressive Stress at Bottom Surface
Example 21	-2.0GPa	43.3% (1.3μm)	-5.0GPa	66.7% (2.0μm)	-2.9GPa	-5.9GPa
Example 22	-3.0GPa	43.3% (1.3μm)	-5.0GPa	66.7% (2.0μm)	-3.1GPa	-6.0GPa
Example 23	-4.5GPa	23.3% (0.7μm)	-5.1GPa	66.7% (2.0μm)	-3.0GPa	-6.0GPa
Example 24	-2.3GPa	23.3% (0.7μm)	-4.9GPa	50.0% (1.5μm)	-2.9GPa	-6.0GPa
Example 25	-3.9GPa	6.7% (0.2μm)	-5.0GPa	50.0% (1.5μm)	-3.0GPa	-6.1GPa
Example 26	-4.1GPa	1.7% (0.05μm)	-4.9GPa	50.0% (1.5μm)	-3.0GPa	-6.1GPa

It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 15 above show compressive stresses exhibited at the surface of the coated film and at the bottom surface of the coated film respectively. In addition, numeric values in a field of the first intermediate point and in a field of the second intermediate point show distances in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point and to the second intermediate point respectively (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with "μm"). Moreover, numeric values in a field of the relative maximum point and in a field of the relative minimum point show the compressive stresses at that relative maximum point and relative minimum point respectively.

The surface-coated cutting tool according to the present invention in Examples 15 21 to 26 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the

compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the

5 compressive stress continuously decreases from the first intermediate point toward the second intermediate point located between the first intermediate point and the bottom surface of the coated film, attains the relative minimum point at the second intermediate point, and continuously increases from the second intermediate point toward the bottom surface of the coated film. That is, this strength distribution shows the strength

10 distribution according to the third embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was maintained at -150V for 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 5).

15 In the surface-coated cutting tool according to Comparative Example 5, the strength distribution of the compressive stress of the coated film had no relative maximum point nor relative minimum point and the compressive stress uniformly decreased from the bottom surface of the coated film toward the surface of the coated film.

20 <Examples 27 to 30>

<Fabrication of Surface-Coated Cutting Tool>

Initially, a base material the same as that used in Examples 21 to 26 was employed as the base material for the surface-coated cutting tool, and this base material was attached to a cathode arc ion plating apparatus.

25 In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

5 Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.8}Si_{0.2}N$ is formed to a thickness of 3 μm as a coated film formed on the base material to be in direct contact therewith. Nitrogen serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as
10 shown in Table 16 below. In this manner, an arc current of 100A was supplied to the cathode electrode and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 27 to 30 having strength distribution of the compressive stress shown in Table 17 below was fabricated.

15 Table 16

No.	Substrate Bias Voltage / Elapsed Time		
Example 27	Start to 30 minutes -170V to -100V	30 minutes to 58 minutes -100V to -200V	58 minutes to 60 minutes -200V to -70V
Example 28	Start to 30 minutes -170V to -100V	30 minutes to 58 minutes -100V to -170V	58 minutes to 60 minutes -170V to -70V
Example 29	Start to 30 minutes -150V to -50V	30 minutes to 58 minutes -50V to -120V	58 minutes to 60 minutes -120V to -70V
Example 30	Start to 30 minutes -150V to -50V	30 minutes to 58 minutes -50V to -100V	58 minutes to 60 minutes -100V to -70V

20 The time in Table 16 above, as in Table 14, shows an elapsed time since evaporation of the metal ions from the target made of alloy was started. In addition, a numeric value of the voltage in each field, as in Table 14, shows a substrate bias voltage set during the elapsed time described above.

Table 17

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Second Intermediate Point	Relative Minimum Point	Compressive Stress at Bottom Surface
Example 27	-3.0GPa	6.7% (0.2 μ m)	-8.0GPa	50% (1.5 μ m)	-3.9GPa	-6.1GPa
Example 28	-3.0GPa	6.7% (0.2 μ m)	-6.1GPa	50% (1.5 μ m)	-4.0GPa	-5.9GPa
Example 29	-3.1GPa	6.7% (0.2 μ m)	-4.5GPa	50% (1.5 μ m)	-2.0GPa	-5.0GPa
Example 30	-2.9GPa	6.7% (0.2 μ m)	-3.9GPa	50% (1.5 μ m)	-2.0GPa	-4.9GPa

It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 17 above, as in Table 15, show compressive stresses exhibited at the surface of the coated film and at the bottom surface of the coated film respectively. In addition, numeric values in a field of the first intermediate point and in a field of the second intermediate point, as in Table 15, also show distances in the direction of thickness of the coated film from the surface of the coated film to respective intermediate points (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with " μ m"). Moreover, numeric values in a field of the relative maximum point and in a field of the relative minimum point, as in Table 15, also show compressive stresses at those points respectively.

The surface-coated cutting tool according to the present invention in Examples 27 to 30 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface

of the coated film and the bottom surface of the coated film and attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the second intermediate point located between the first intermediate point and the bottom surface of the coated film, attains the relative minimum point at the second intermediate point, and continuously increases from the second intermediate point toward the bottom surface of the coated film. That is, this strength distribution shows the strength distribution according to the third embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was uniformly decreased from -200V to -20V taking 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 6).

In the surface-coated cutting tool according to Comparative Example 6, the strength distribution of the compressive stress of the coated film had no relative maximum point or relative minimum point and the compressive stress uniformly decreased from the bottom surface of the coated film toward the surface of the coated film.

<Evaluation of Wear-Resistance of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 21 to 30 and Comparative Examples 5 and 6 fabricated as above was subjected to a wet (water-soluble emulsion) continuous cutting test and an interrupted cutting test under the condition shown in Table 1 above. Then, the time at which a flank wear width at the cutting edge exceeds 0.2mm was measured as the cutting time.

Tables 18 and 19 show the cutting time measured as described above as the result of evaluation of wear resistance of the surface-coated cutting tool. As the cutting time is longer, wear resistance is superior. In addition, in the continuous cutting test, shine on a finished surface of a material to be cut was also observed. Tables 18 and 19 also show the result of observation. Here, "shiny" indicates that the finished surface of

the material to be cut had a shine, while "dim" indicates that the finished surface of the material to be cut had no shine but was dim.

As can clearly be seen from Tables 18 and 19, in both of the continuous cutting test and the interrupted cutting test, as compared with the surface-coated cutting tool in Comparative Examples 5 and 6, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 21 to 30 attained further improved wear resistance (see the continuous cutting test) and toughness (see the interrupted cutting test), excellent resistance to film chipping as a result of shine on the finished surface, and further improved life.

10 <Evaluation of Shine on Finished Surface of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 21 to 30 and Comparative Examples 5 and 6 fabricated as above was subjected to a test for evaluating shine on the finished surface under the condition shown below.

15 As to the condition for cutting, specifically, as shown in Table 1 above, S45C was used as a material to be cut. A wet turning test was performed for 10 minutes under such a condition that a cutting speed was set to 200m/min, a feed rate was set to 0.2mm/rev, and cutting was set to 0.5mm.

20 Tables 18 and 19 show the result of evaluation of shine on the finished surface of each surface-coated cutting tool. As can clearly be seen from Tables 18 and 19, as compared with the surface-coated cutting tool in Comparative Examples 5 and 6, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 21 to 30 attained further improved shine on the finished surface and excellent resistance to film chipping.

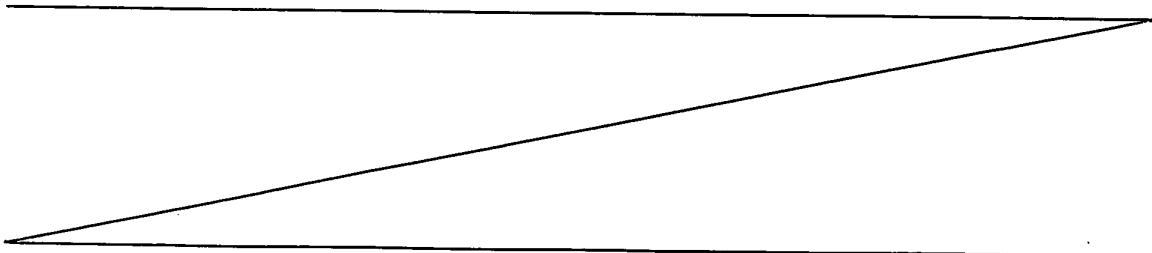


Table 18

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 21	112 minutes (shiny)	23 minutes	Excellent shine
Example 22	103 minutes (shiny)	24 minutes	Excellent shine
Example 23	85 minutes (shiny)	30 minutes	Excellent shine
Example 24	108 minutes (shiny)	25 minutes	Excellent shine
Example 25	89 minutes (shiny)	32 minutes	Excellent shine
Example 26	79 minutes (shiny)	36 minutes	Excellent shine
Comparative Example 5	12 minutes (dim)	3 minutes	Dim

Table 19

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 27	99 minutes (shiny)	37 minutes	Good shine
Example 28	105 minutes (shiny)	34 minutes	Excellent shine
Example 29	98 minutes (shiny)	33 minutes	Excellent shine
Example 30	96 minutes (shiny)	32 minutes	Excellent shine
Comparative Example 6	27 minutes (dim)	25 seconds	Chipping observed in 3 minutes

5

<Examples 31 to 36>

<Fabrication of Surface-Coated Cutting Tool>

Initially, as the base material for the surface-coated cutting tool, a throw away tip for cutting having a material and a tool shape (different depending on a method of evaluating each characteristic which will be described later) shown in Table 1 above was prepared, and the throw away tip (base material) was attached to a cathode arc ion plating apparatus.

In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to 450°C

by means of a heater provided in the apparatus. The chamber was evacuated until the pressure within the chamber attained to 1.0×10^{-4} Pa.

Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.5}Al_{0.5}N$ is formed to a thickness of 3 μ m as a coated film formed on the base material to be in direct contact therewith. Nitrogen gas serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 20 below. In this manner, an arc current of 100A was supplied to the cathode electrode for 60 minutes and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 31 to 36 having strength distribution of the compressive stress shown in Table 21 below was fabricated.

Table 20

No.	First Cycle (Time / Substrate Bias Voltage)	Second Cycle (Time / Substrate Bias Voltage)
Example 31	15 minutes -50V to -150V	15 minutes -150V to -50V
Example 32	10 minutes -50V to -150V	10 minutes -150V to -50V
Example 33	3 minutes -50V to -150V	3 minutes -150V to -50V
Example 34	1 minute -50V to -150V	3 minutes -150V to -50V
Example 35	12 minutes -210V to -20V	12 minutes -20V to -210V
Example 36	12 minutes -150V to -75V	12 minutes -75V to -150V

The "first cycle" and the "second cycle" in Table 20 above indicate that the

substrate bias voltage is applied as a result of alternately repeating, for 60 minutes, these cycles lasting for the time period shown in the fields of the first and second cycles (the cycle starts from the "first cycle", however, it is not necessary to end with the "second cycle"). That is, the time shown in each field of cycle shows the elapsed time during

5 which the metal ion evaporates from the target made of alloy. A numeric value of the voltage in each field shows a substrate bias voltage set during the elapsed time described above. For example, if a range such as "-50V to -150V" is shown, it indicates that the substrate bias voltage was gradually increased from -50V to -150V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually

10 increases. Meanwhile, if a range such as "-150V to -50V" is shown, it indicates that the substrate bias voltage was gradually decreased from -150V to -50V at a constant speed during the elapsed time. Here, the compressive stress of the coated film gradually decreases. The relative maximum point and the relative minimum point of the compressive stress are formed at a point where the increase in the voltage turns to

15 decrease (that is, at a point where switching from "the first cycle" to "the second cycle" is made) and at a point where the decrease in the voltage turns to increase (that is, at a point where switching from "the second cycle" to "the first cycle" is made), respectively.

The substrate bias voltage was varied relative to the elapsed time, so that the relative maximum point and the relative minimum point or continuous increase or decrease in the strength distribution of the compressive stress in the coated film can be formed.

Table 21

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Second Intermediate Point	Minimum Point	Relative Count / Distance	Maximum Point Count / Distance	Relative Minimum Point Count / Distance	Compressive Stress at Bottom Surface
Example 31	-2GPa	25% 0.75μm	-5.2GPa to -4.8GPa	50% 1.5μm	-2GPa	2 / 1.5μm	2 / 1.5μm	1 / -1.0μm	-2GPa
Example 32	-2GPa	16.7% 0.5μm	-5.2GPa to -4.8GPa	33.3% 1.0μm	-2.0GPa to -1.6GPa	3 / 1.0μm	3 / 1.0μm	2 / 1.0μm	-2GPa
Example 33	-2GPa	5% 0.15μm	-5.3GPa to -4.7GPa	10% 0.3μm	-2.0GPa to -1.6GPa	10 / 0.3μm	10 / 0.3μm	9 / 0.3μm	-2GPa
Example 34	-2GPa	1.7% 0.05μm	-5.4GPa to -4.6GPa	6.7% 0.2μm	-2.0GPa to -1.6GPa	15 / 0.2μm	15 / 0.2μm	14 / 0.2μm	-2GPa
Example 35	-1GPa	20% 0.6μm	-7.1GPa to -6.8GPa	40% 1.2μm	-1.1GPa to -0.8GPa	2 / 1.2μm	2 / 1.2μm	2 / 1.2μm	-7GPa
Example 36	-3GPa	20% 0.6μm	-5.2GPa to -4.8GPa	40% 1.2μm	-3.3GPa to -2.9GPa	2 / 1.2μm	2 / 1.2μm	2 / 1.2μm	-5GPa

It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 21 above show compressive stresses exhibited at the surface of the coated film and at the bottom surface of the coated film respectively. In addition, numeric values in a field of the first 5 intermediate point and in a field of the second intermediate point show distances in the direction of thickness of the coated film from the surface of the coated film to the first intermediate point and to the second intermediate point respectively (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with " μm "). Moreover, numeric values in a field of the relative maximum 10 point and in a field of the relative minimum point show compressive stresses at the relative maximum point and relative minimum point respectively (though the numeric value is shown as a range, it is assumed that the compressive stress attains any substantially identical value within this range). In addition, relative maximum point 15 count / distance and relative minimum point count / distance represent the number of relative maximum points and relative minimum points present between the surface of the coated film and the bottom surface of the coated film, as well as a distance between the relative maximum points and a distance between the relative minimum points, respectively.

The surface-coated cutting tool according to the present invention in Examples 20 31 to 36 includes the base material and the coated film formed on the base material. The coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction 25 of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the

second intermediate point located between the first intermediate point and the bottom surface of the coated film and attains the relative minimum point at the second intermediate point, and the strength distribution has one or more similar relative maximum point and one or more similar relative minimum point between the second 5 intermediate point and the bottom surface of the coated film. These relative maximum points and relative minimum points are present in an alternate and repeated manner in this order. In each example, the compressive stress at each relative maximum point attains a substantially identical value and the compressive stress at each relative minimum point attains a substantially identical value. The relative maximum points or 10 the relative minimum points are present at substantially equal intervals. That is, this strength distribution shows exemplary strength distribution according to the fourth embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was maintained at 15 $-150V$ for 60 minutes, after evaporation of the metal ion from the target made of alloy is started (Comparative Example 7).

In the surface-coated cutting tool according to Comparative Example 7, there was no strength distribution of the compressive stress of the coated film and the compressive stress was constant from the bottom surface of the coated film to the 20 surface of the coated film.

<Examples 37 to 40>

<Fabrication of Surface-Coated Cutting Tool>

Initially, a base material the same as that used in Examples 31 to 36 was employed as the base material for the surface-coated cutting tool, and this base material 25 was attached to a cathode arc ion plating apparatus.

In succession, the pressure within the chamber of the apparatus was lowered by means of a vacuum pump, and the temperature of the base material was heated to $450^{\circ}C$ by means of a heater provided in the apparatus. The chamber was evacuated until the

pressure within the chamber attained to 1.0×10^{-4} Pa.

Thereafter, argon gas was introduced and the pressure within the chamber was held at 3.0Pa. The voltage of a substrate bias power supply of the base material was gradually raised to -1500V, and cleaning of the surface of the base material was performed for 15 minutes. Thereafter, the argon gas was exhausted.

Then, a target made of alloy serving as a metal evaporation source was set such that $Ti_{0.7}Si_{0.2}Cr_{0.1}N$ is formed to a thickness of 3 μ m as a coated film formed on the base material to be in direct contact therewith. Nitrogen serving as the reactive gas was introduced, the temperature of the base material (substrate) was set to 450°C, the reactive gas pressure was set to 4.0Pa, and the substrate bias voltage was varied as shown in Table 22 below. In this manner, an arc current of 100A was supplied to the cathode electrode for 60 minutes and metal ions were generated from an arc type evaporation source, whereby the surface-coated cutting tool according to the present invention of Examples 37 to 40 having strength distribution of the compressive stress shown in Table 23 below was fabricated.

Table 22

No.	First Cycle (Time / Substrate Bias Voltage)	Second Cycle (Time / Substrate Bias Voltage)
Example 37	6 minutes -20V to -180V	6 minutes -180V to -20V
Example 38	6 minutes -60V to -180V	6 minutes -180V to -60V
Example 39	6 minutes -75V to -180V	6 minutes -180V to -75V
Example 40	6 minutes -150V to -180V	6 minutes -180V to -150V

The "first cycle" and the "second cycle" in Table 22 above, as in Table 20, indicate that the substrate bias voltage is applied as a result of alternately repeating, for 60 minutes, these cycles lasting for the time period shown in the fields of the first and second cycles (the cycle starts from the "first cycle"). In addition, a numeric value of the time and the voltage in each field, as in Table 20, shows a substrate bias voltage set during the elapsed time.

Table 23

No.	Compressive Stress at Surface	First Intermediate Point	Relative Maximum Point	Second Intermediate Point	Relative Minimum Point	Relative Maximum Point	Relative Minimum Point	Compressive Stress at Bottom Surface
					Count / Distance	Count / Distance	Count / Distance	
Example 37	-1GPa	10% 0.3μm	-6.2GPa to -5.8GPa	20% 0.6μm	-1.2GPa to -0.8GPa	5 / 0.6μm	4 / 0.6μm	-1GPa
Example 38	-2GPa	10% 0.3μm	-6.2GPa to -5.8GPa	20% 0.6μm	-2.2GPa to -1.8GPa	5 / 0.6μm	4 / 0.6μm	-2GPa
Example 39	-3GPa	10% 0.3μm	-6.2GPa to -5.8GPa	20% 0.6μm	-3.3GPa to -3.0GPa	5 / 0.6μm	4 / 0.6μm	-3GPa
Example 40	-5GPa	10% 0.3μm	-6.2GPa to -5.8GPa	20% 0.6μm	-5.2GPa to -4.8GPa	5 / 0.6μm	4 / 0.6μm	-5GPa

It is noted that numeric values in a field of the compressive stress at the surface and in a field of the compressive stress at the bottom surface in Table 23 above, as in Table 21, show compressive stresses exhibited at the surface of the coated film and at the bottom surface of the coated film respectively. In addition, numeric values in a field 5 of the first intermediate point and in a field of the second intermediate point, as in Table 21, also show distances in the direction of thickness of the coated film from the surface of the coated film to respective intermediate points (a numeric value shown with "%" is a value relative to the thickness of the coated film, accompanied by the indication with "μm"). Moreover, numeric values in a field of the relative maximum point and in a field 10 of the relative minimum point, as in Table 21, also show compressive stresses at those points respectively (though the numeric value is shown as a range, it is assumed that the compressive stress attains any substantially identical value within this range). In addition, relative maximum point count / distance and relative minimum point count / distance, as in Table 21, represent the number of relative maximum points and relative minimum 15 points present between the surface of the coated film and the bottom surface of the coated film, as well as a distance between the relative maximum points and a distance between the relative minimum points, respectively.

The surface-coated cutting tool according to the present invention in Examples 37 to 40 includes the base material and the coated film formed on the base material. The 20 coated film serves as the outermost layer on the base material and has compressive stress. The compressive stress is varied so as to have strength distribution in a direction of thickness of the coated film, and the strength distribution is characterized in that the compressive stress at the surface of the coated film continuously increases from the surface of the coated film toward the first intermediate point located between the surface 25 of the coated film and the bottom surface of the coated film and the compressive stress attains the relative maximum point at the first intermediate point, and that the compressive stress continuously decreases from the first intermediate point toward the second intermediate point located between the first intermediate point and the bottom

surface of the coated film and attains the relative minimum point at the second intermediate point, and the strength distribution has one or more similar relative maximum point and one or more similar relative minimum point between the second intermediate point and the bottom surface of the coated film. These relative maximum 5 points and relative minimum points are present in an alternate and repeated manner in this order. In each example, the compressive stress at each relative maximum point attains a substantially identical value and the compressive stress at each relative minimum point attains a substantially identical value. The relative maximum points or the relative minimum points are present at substantially equal intervals. That is, this 10 strength distribution shows exemplary strength distribution according to the fourth embodiment described above.

For the purpose of comparison, a surface-coated cutting tool was fabricated in a similar manner, except for a condition that the substrate bias voltage was uniformly decreased from -200V to -20V taking 60 minutes, after evaporation of the metal ion 15 from the target made of alloy is started (Comparative Example 8).

In the surface-coated cutting tool according to Comparative Example 8, the strength distribution of the compressive stress of the coated film had no relative maximum point nor the relative minimum point, and the compressive stress uniformly decreased from the bottom surface of the coated film toward the surface of the coated 20 film.

<Evaluation of Wear-Resistance of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 31 to 40 and Comparative Examples 7 and 8 fabricated as above was subjected to a wet (water-soluble emulsion) continuous cutting test and an interrupted cutting test under the 25 condition shown in Table 1 above. Then, the time at which a flank wear width at the cutting edge exceeds 0.2mm was measured as the cutting time.

Tables 24 and 25 show the cutting time measured as described above as the result of evaluation of wear resistance of the surface-coated cutting tool. As the cutting

time is longer, wear resistance is superior. In addition, in the continuous cutting test, shine on a finished surface of a material to be cut was also observed. Tables 24 and 25 also show the result of observation. Here, "shiny" indicates that the finished surface of the material to be cut had a shine, while "dim" indicates that the finished surface of the material to be cut had no shine but was dim.

As can clearly be seen from Tables 24 and 25, in both of the continuous cutting test and the interrupted cutting test, as compared with the surface-coated cutting tool in Comparative Examples 7 and 8, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 31 to 40 attained further improved wear resistance (see the continuous cutting test) and toughness (see the interrupted cutting test), excellent resistance to film chipping as a result of shine on the finished surface, and further improved life.

<Evaluation of Shine on Finished Surface of Surface-Coated Cutting Tool>

Each of the surface-coated cutting tools according to Examples 31 to 40 and Comparative Examples 7 and 8 fabricated as above was subjected to a test for evaluating shine on the finished surface under the condition shown below.

As to the condition for cutting, specifically, as shown in Table 1 above, S45C was used as a material to be cut. A wet turning test was performed for 10 minutes under such a condition that a cutting speed was set to 200m/min, a feed rate was set to 0.2mm/rev, and cutting was set to 0.5mm.

Tables 24 and 25 show the result of evaluation of shine on the finished surface of each surface-coated cutting tool. As can clearly be seen from Tables 24 and 25, as compared with the surface-coated cutting tool in Comparative Examples 7 and 8, it was confirmed that the surface-coated cutting tool according to the present invention in Examples 31 to 40 attained further improved shine on the finished surface and excellent resistance to film chipping.

Table 24

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 31	112 minutes (shiny)	24 minutes	Excellent shine
Example 32	116 minutes (shiny)	27 minutes	Excellent shine
Example 33	123 minutes (shiny)	29 minutes	Excellent shine
Example 34	118 minutes (shiny)	30 minutes	Excellent shine
Example 35	119 minutes (shiny)	28 minutes	Excellent shine
Example 36	97 minutes (shiny)	30 minutes	Excellent shine
Comparative Example 7	12 minutes (dim)	3 minutes	Dim

Table 25

No.	Evaluation of Wear Resistance		Evaluation of Shine on Finished Surface
	Continuous Cutting Test	Interrupted Cutting Test	
Example 37	132 minutes (shiny)	25 minutes	Excellent shine
Example 38	129 minutes (shiny)	34 minutes	Excellent shine
Example 39	125 minutes (shiny)	42 minutes	Excellent shine
Example 40	83 minutes (shiny)	40 minutes	Good shine
Comparative Example 8	31 minutes (dim)	21 seconds	Chipping observed in 3 minutes

5

The embodiments and examples disclosed above are by way of illustration and are not to be taken by way of limitation, the spirit and scope of the present invention being limited not by the embodiments and examples above but by the claims and intended to include all modifications and variations within the scope of the claims.